

# Bridgetek Pte Ltd

## FT900/1/2/3 Revision C

### (Embedded Microcontroller)



The FT90X series includes the FT900, FT901, FT902 and FT903 which are complete System-On-Chip 32-bit RISC microcontrollers for embedded applications featuring a high level of integration and low power consumption. It has the following features:

- High performance, low power 32-bit FT32 core processor, running at a frequency of 100MHz.
- 256kB on-chip Flash memory.
- 256kB on-chip shadow program memory.
- True Zero Wait States (OWS) up to 3.1 DMIPS per MHz performance.
- 64kB on-chip data memory.
- OTP memory for security configuration.
- Integrated Phase-Locked Loop (PLL) supports external 12MHz crystal and direct external clock source input.
- 32.768 kHz Real Time Clock (RTC) support.
- Power-On Reset (POR).
- One USB2.0 EHCI compatible host controller supports high-speed (480 Mbit/s), full-speed (12 Mbit/s), and low-speed (1.5 Mbit/s).
- One USB2.0 device controller supports high-speed (480 Mbit/s) and full-speed (12 Mbit/s).
- USB2.0 host and device controllers support the Isochronous, Interrupt, Control, and Bulk transfers.
- USB2.0 device controller supports the high-bandwidth isochronous IN transaction.
- 10/100 Mbps Ethernet that is compliant with the IEEE 802.3/802.3u standards. (FT900 and FT901 only).
- Supports One-Wire debugger for downloading firmware to Flash memory or shadow program memory, and supports a software debugger.
- Two CAN controllers support CAN protocol 2.0 parts A & B, data rate is up to 1 Mbit/s. (FT900 and FT902 only).
- One SPI master supports single / dual / quad modes of data transfer. The clock rate is up to 50 MHz.
- Two SPI slaves support single data transfer with 25MHz clock.
- Two I<sup>2</sup>C bus interfaces (one master and one slave) which support standard / fast / fast plus / high speed mode data transfers of up to 3.4 Mbit/s. Clock stretching is supported.
- I<sup>2</sup>S bus interface can be configured as master or slave. Two clock input options (24.576 MHz and 22.5792 MHz) to support I<sup>2</sup>S master mode for different audio sample rates.
- UART interface can be configured as one full programmable UART0 or two simple interfaces, UART0 and UART1 with CTS / RTS control function.
- Four user timers with individual pre-scaler and a watchdog function.
- 8-bit parallel data interface supports camera data capturing.
- Supports 7 independent PWM channels. Channel 0 and 1 can be configured as PCM 8-bit/16-bit stereo audio output.
- SD host controller is compliant with standard specification V3.0/SDIO specification V2.0/MMC card specification V4.3. It supports up to 50 MHz SD clock speed and software supports SD card format in SD/SDHC/SDXC.
- Supports two 10-bit DAC 0/1 channels output, sample rate at ~1 MS/s.
- Supports seven 10-bit ADC 1/7 channels input, sample rate is up to ~960 kS/s.
- Single 3.3 volt power supply and built-in 1.2 V regulators.
- 3.3 volt I/O power supply.
- Supports USB Battery Charging Specification Rev 1.2. Downstream port can be configured as SDP, CDP or DCP. Upstream port can perform BCD mode detection.
- Supports VBUS power switching and over current control.
- -40°C to 85°C extended operating temperature range.
- Available in compact Pb-free 100-Pin packages (all RoHS compliant).

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# 1 Typical Applications

- Home security system
- Home Automation
- Embedded audio application
- Motor drive and application control
- E-meter
- CCTV monitor
- Industrial automation
- Medical appliances
- Instrumentation
- DAQ System

## 1.1 Part Numbers

| Part Number | Package                                                                                                   |
|-------------|-----------------------------------------------------------------------------------------------------------|
| FT900Q-C-X  | 100 Pin QFN, pitch 0.4mm, body 12mm x 12mm x 0.75mm, support both CAN Bus and Ethernet features.          |
| FT900L-C-X  | 100 Pin LQFP, pitch 0.5mm, body 14mm x 14mm x 1.40mm, support both CAN Bus and Ethernet features.         |
| FT901Q-C-X  | 100 Pin QFN, pitch 0.4mm, body 12mm x 12mm x 0.75mm, support Ethernet, doesn't support CAN Bus.           |
| FT901L-C-X  | 100 Pin LQFP, pitch 0.5mm, body 14mm x 14mm x 1.40mm, support Ethernet, doesn't support CAN Bus.          |
| FT902Q-C-X  | 100 Pin QFN, pitch 0.4mm, body 12mm x 12mm x 0.75mm, support CAN Bus, doesn't support Ethernet.           |
| FT902L-C-X  | 100 Pin LQFP, pitch 0.5mm, body 14mm x 14mm x 1.40mm, support CAN Bus, doesn't support Ethernet.          |
| FT903Q-C-X  | 100 Pin QFN, pitch 0.4mm, body 12mm x 12mm x 0.75mm, doesn't support both CAN Bus and Ethernet features.  |
| FT903L-C-X  | 100 Pin LQFP, pitch 0.5mm, body 14mm x 14mm x 1.40mm, doesn't support both CAN Bus and Ethernet features. |

**Table 1-1 - FT900/1/2/3 Series Part Numbers**

Common Interfaces on all packages include: USB Host, USB Device, SPI, UART, ADC, DAC, I2S, PWM, RTC, Timers/Watchdog, and Interrupt Controller.

**Note:** Packaging codes for X is:

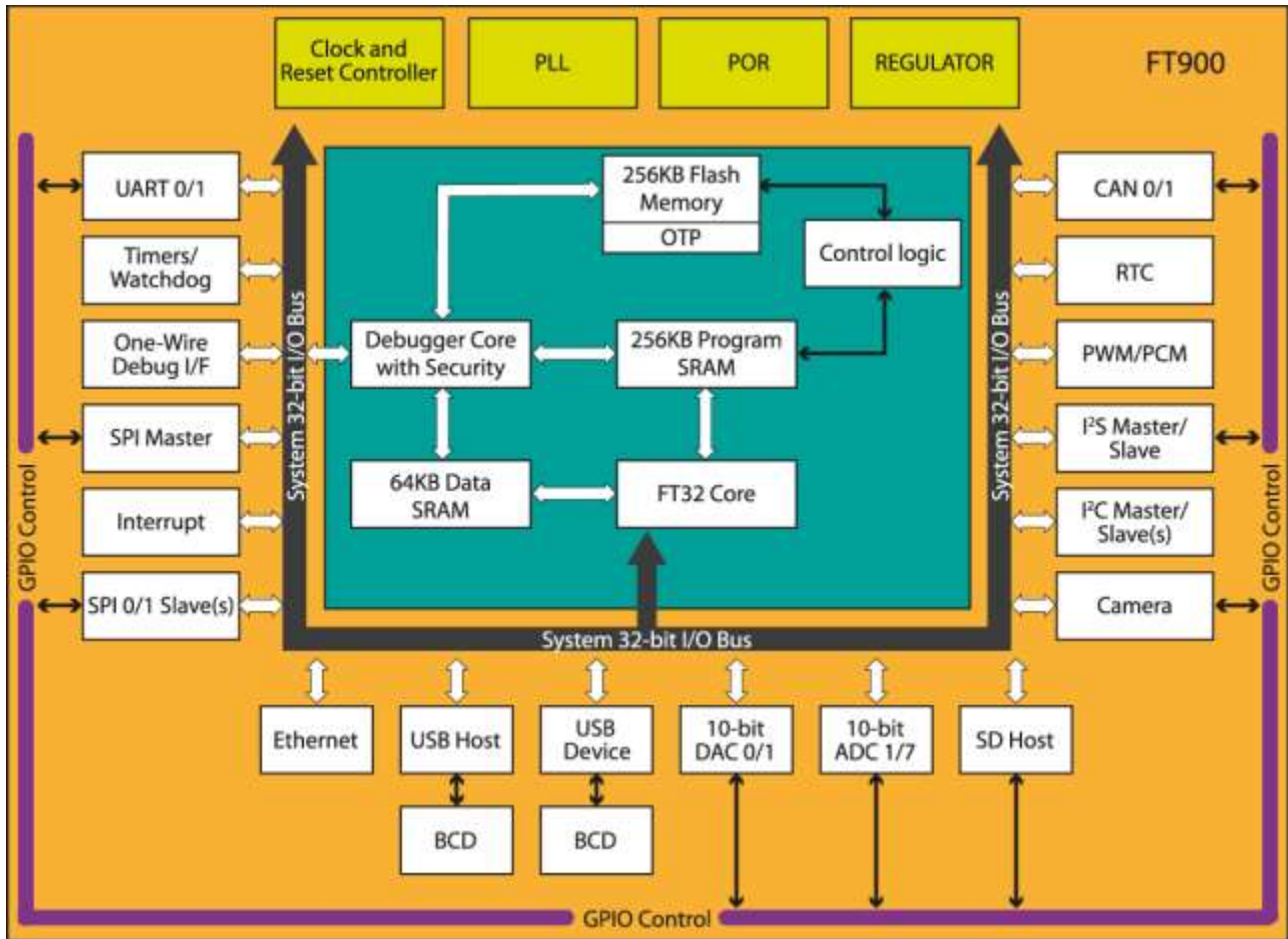
-R: Tape and Reel (Qty per reel is 1000)

-T: Tray packing (Qty per tray for LQFP is 90, qty per tray for QFN is 152)

## 1.2 USB2.0 Compliant

The FT900/1/2/3 series contains a USB2.0 host controller and device controller that both are compliant with the USB 2.0 specification.

## 2 FT900 Block Diagram



**Figure 2-1 - FT900 Block Diagram**

For a description of each function please refer to [Chapter 4](#).

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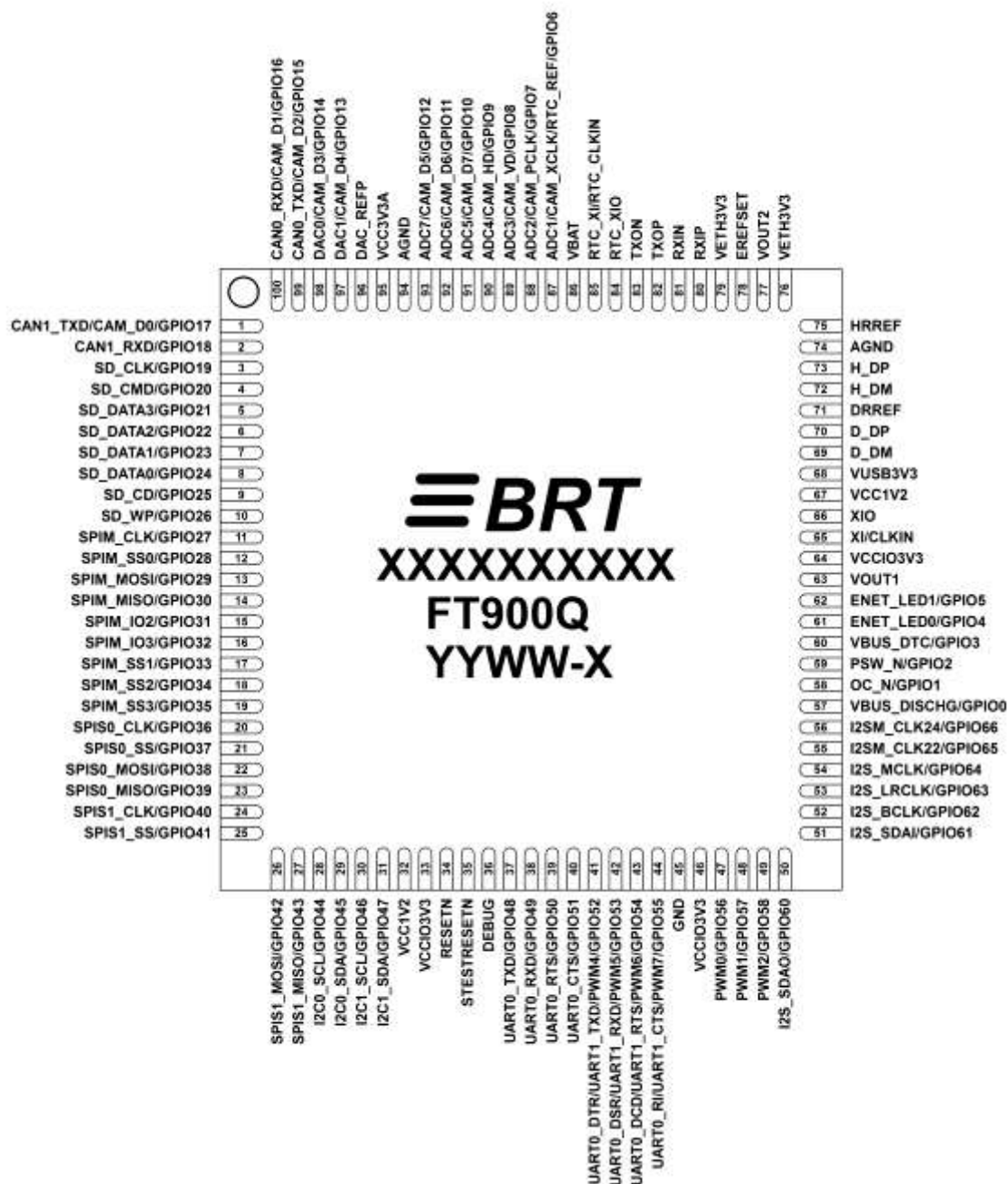
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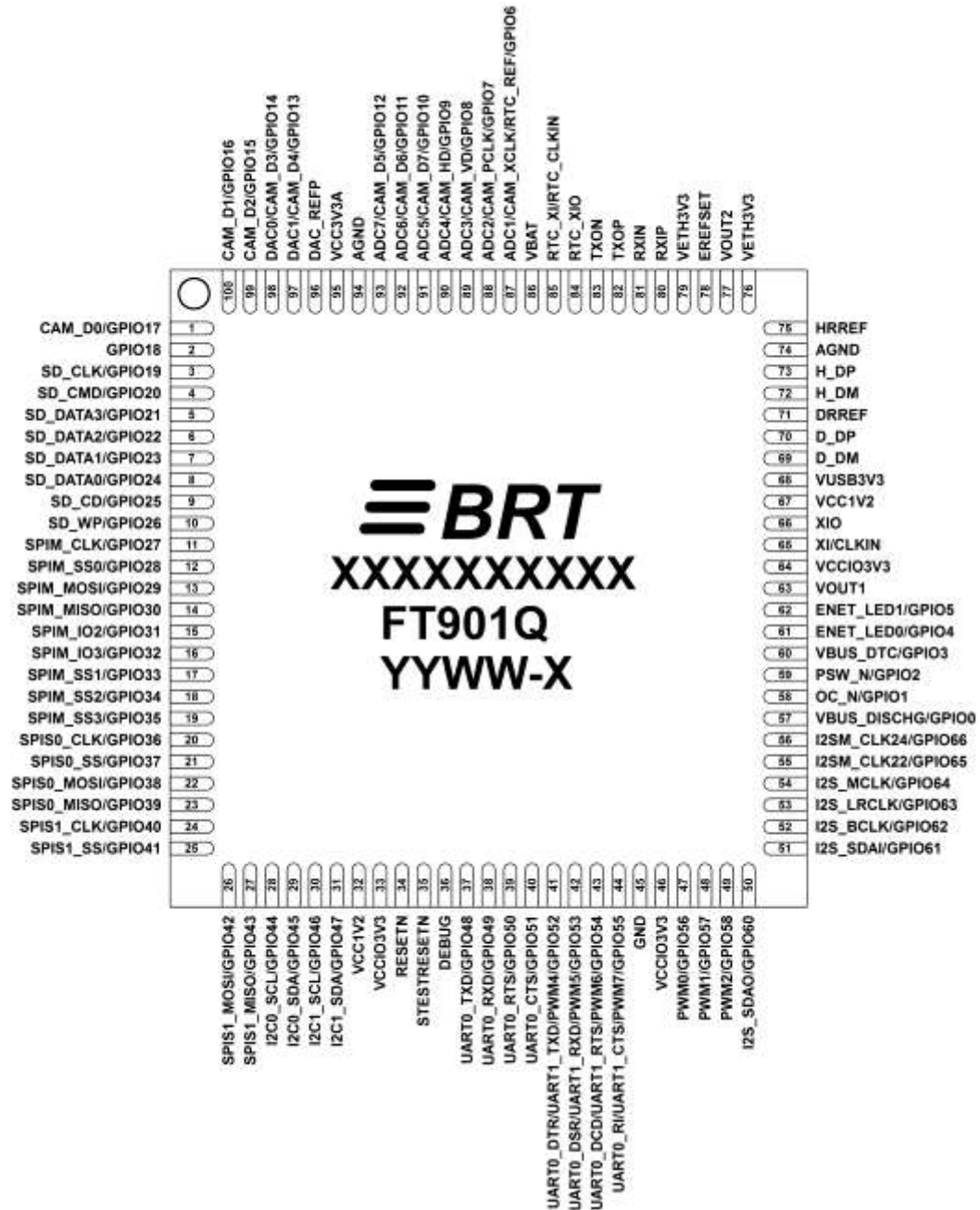
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### 3 Device Pin Out and Signal Description

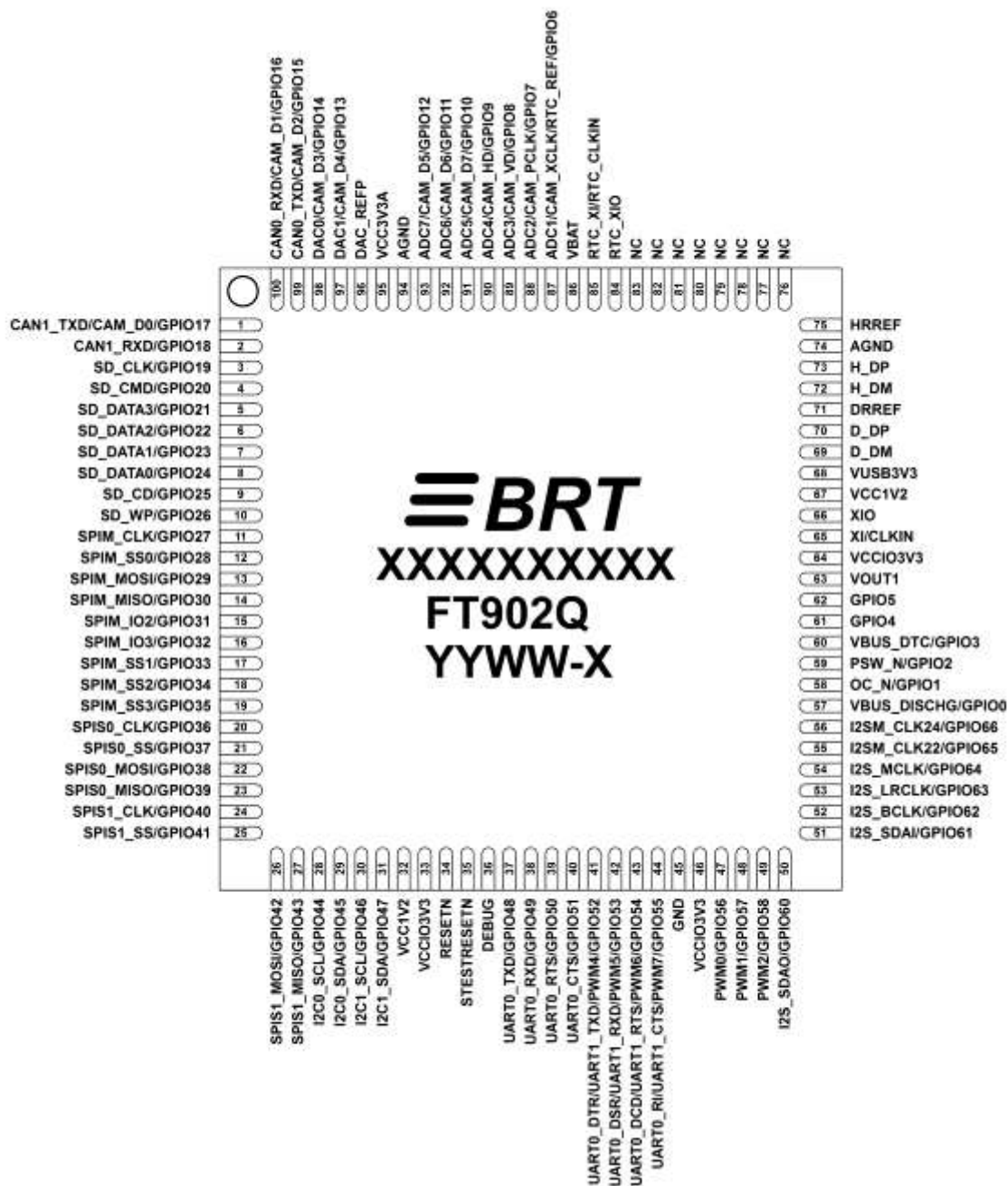
### 3.1 Pin Out – FT900 QFN-100

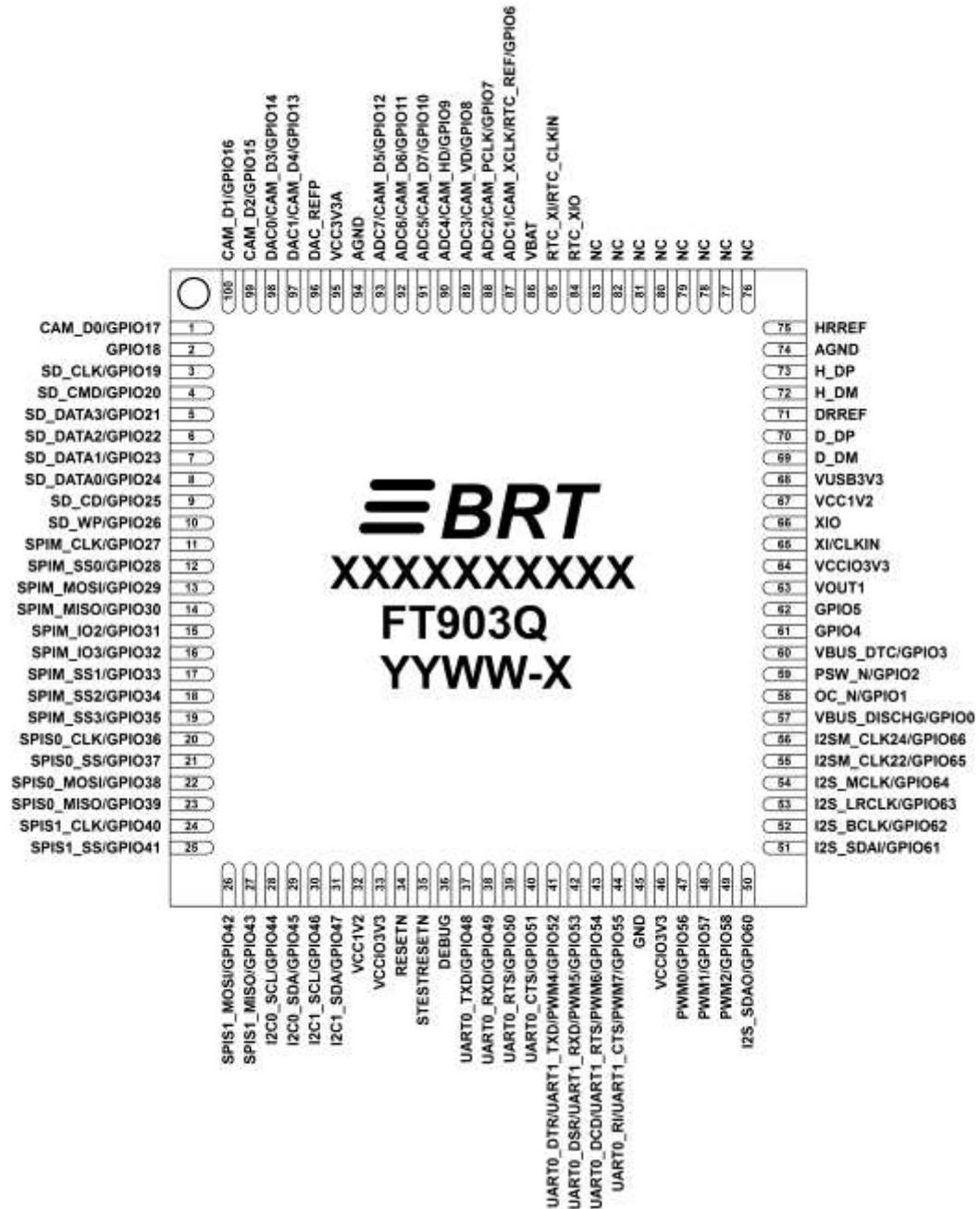


### Figure 3-1 - Pin Configuration FT900Q (top-down view)



**Figure 3-2 - Pin Configuration FT901Q (top-down view)**


**Figure 3-3 - Pin Configuration FT902Q (top-down view)**


**Figure 3-4 - Pin Configuration FT903Q (top-down view)**

## 3.2 Pin Out – FT900 LQFP-100

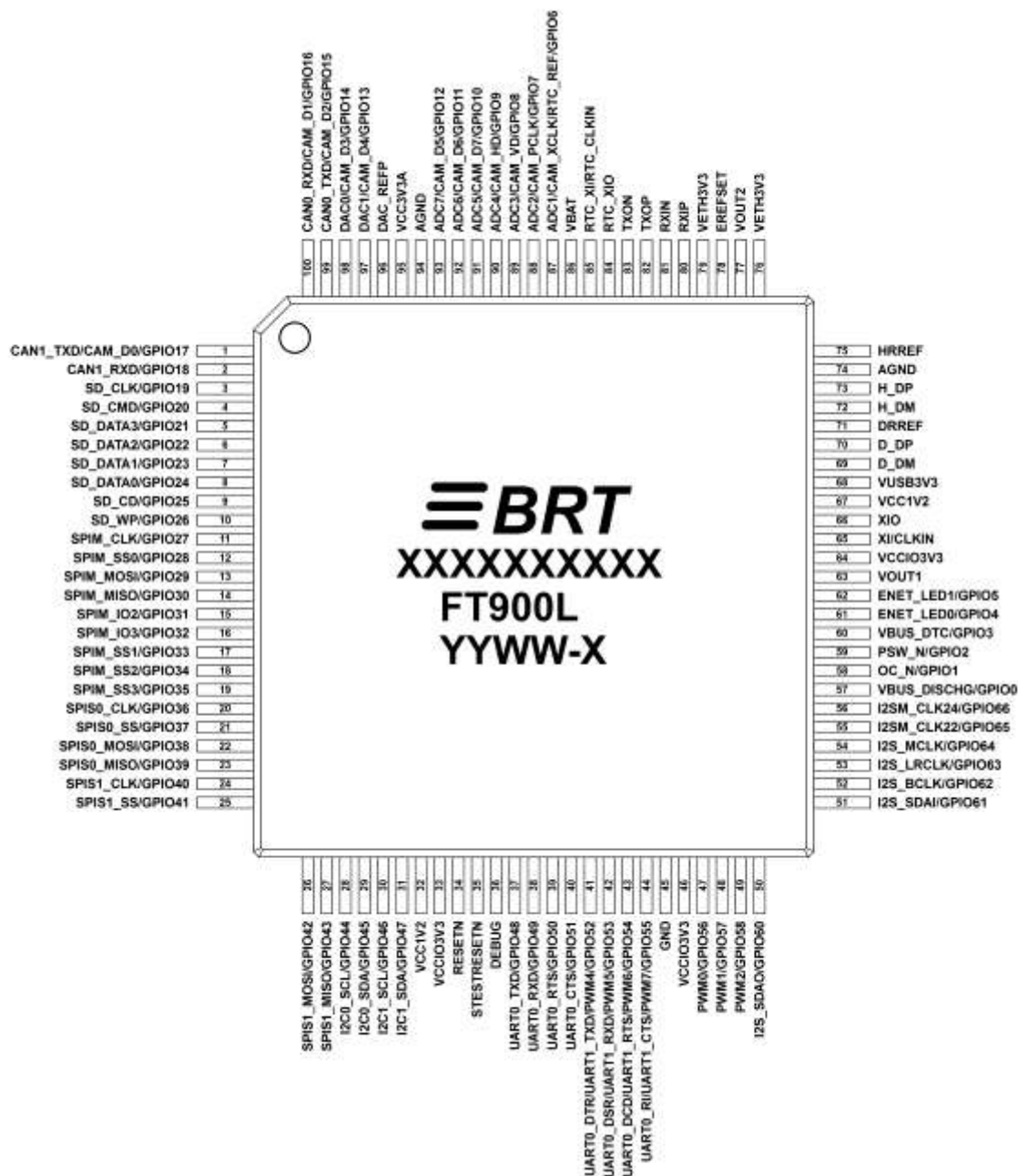
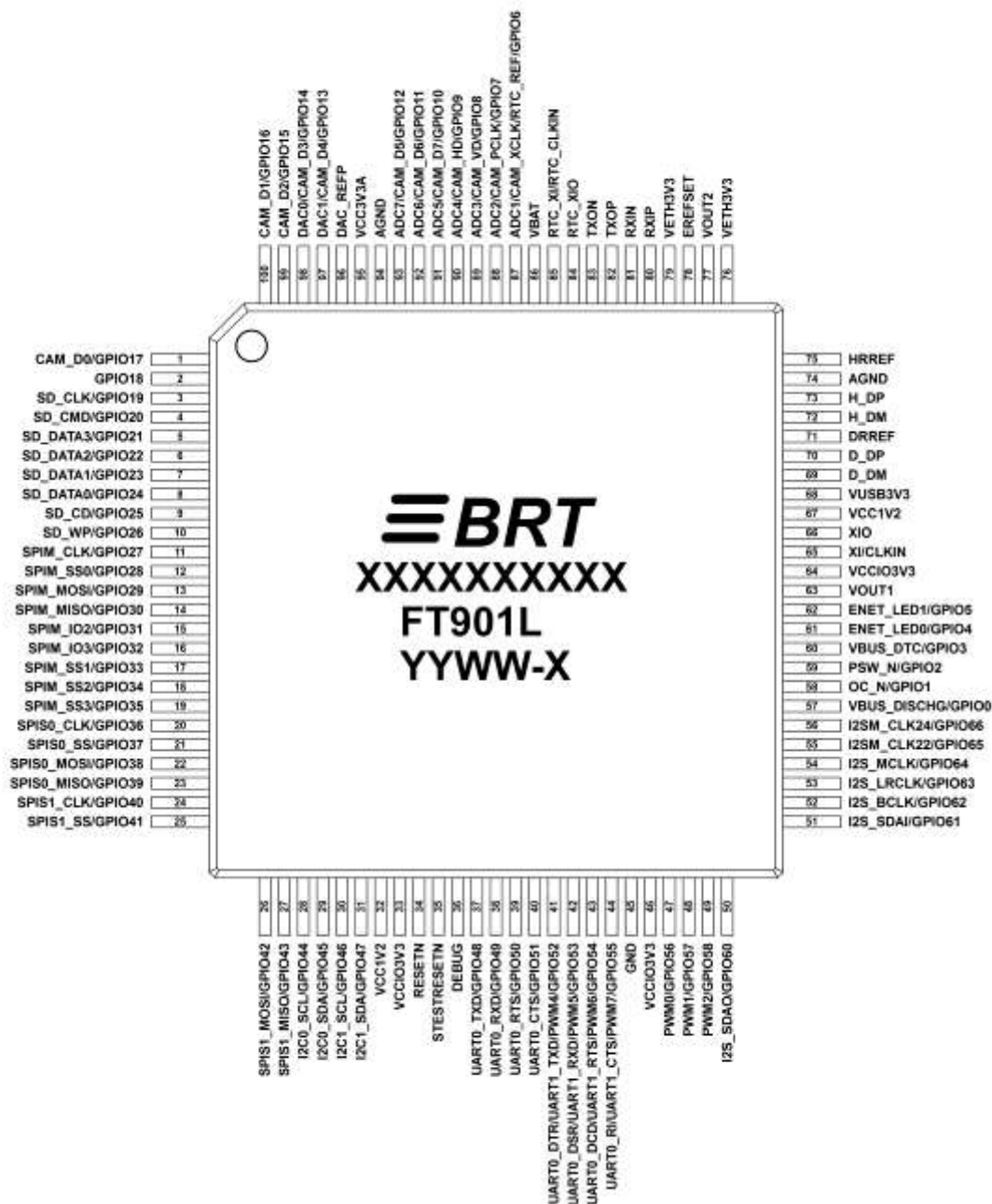
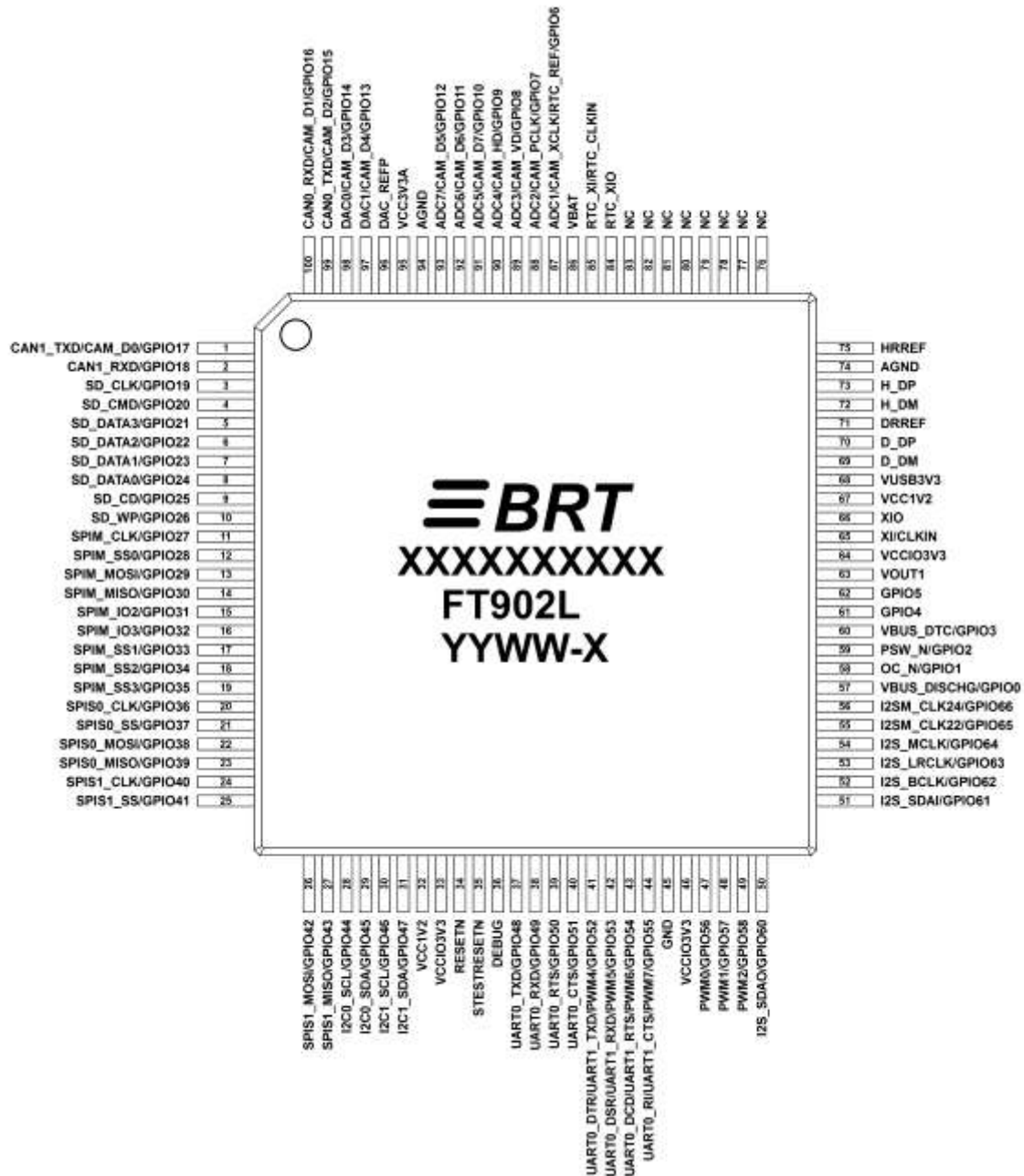


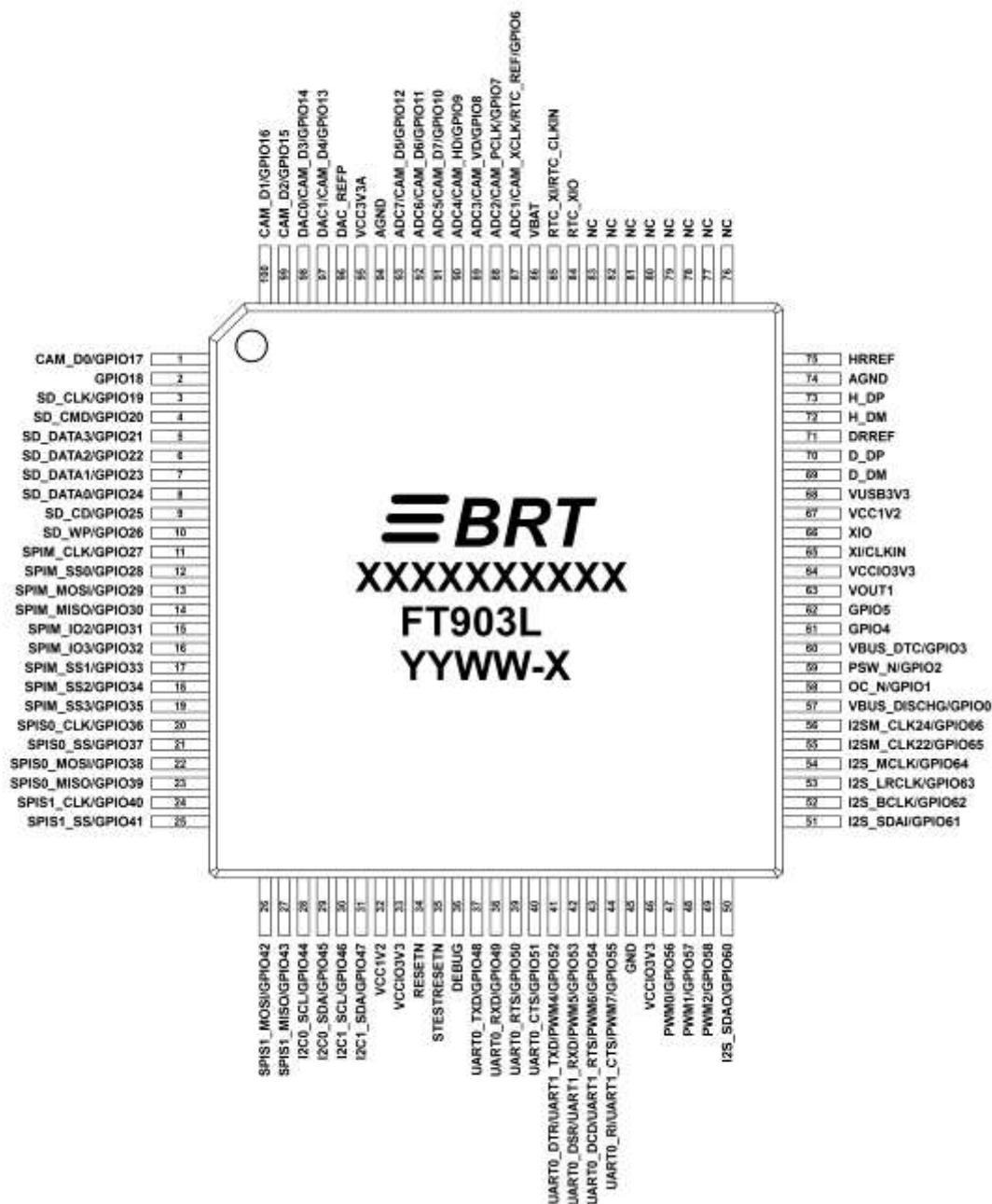
Figure 3-5 - Pin Configuration FT900L (top-down view)



**Figure 3-6 - Pin Configuration FT901L (top-down view)**



**Figure 3-7 - Pin Configuration FT902L (top-down view)**



**Figure 3-8 - Pin Configuration FT903L (top-down view)**

### 3.3 Pin Description

| Pin No. | Name                   | Type | Description                                                                                                                                |
|---------|------------------------|------|--------------------------------------------------------------------------------------------------------------------------------------------|
| 1       | CAN1_TXD/CAM_D0/GPIO17 | I/O  | GPIO17 input/output. (By default is GPIO input, internal pull-low)<br>Camera data 0 input.<br>CAN1 transmitter output. <a href="#">[1]</a> |
| 2       | CAN1_RXD/GPIO18        | I/O  | GPIO18 input/output. (By default is GPIO input, internal pull-low)<br>CAN1 receiver input. <a href="#">[1]</a>                             |
| 3       | SD_CLK/GPIO19          | I/O  | GPIO19 input/output. (By default is GPIO input, internal pull-low)<br>SD card serial clock output.                                         |
| 4       | SD_CMD/GPIO20          | I/O  | GPIO20 input/output. (By default is GPIO input, internal pull-low)<br>SD card command signal input/output.                                 |
| 5       | SD_DATA3/GPIO21        | I/O  | GPIO21 input/output. (By default is GPIO input, internal pull-low)<br>SD card data bus line 3 input/output.                                |
| 6       | SD_DATA2/GPIO22        | I/O  | GPIO22 input/output. (By default is GPIO input, internal pull-low)<br>SD card data bus line 2 input/output.                                |
| 7       | SD_DATA1/GPIO23        | I/O  | GPIO23 input/output. (By default is GPIO input, internal pull-low)<br>SD card data bus line 1 input/output.                                |
| 8       | SD_DATA0/GPIO24        | I/O  | GPIO24 input/output. (By default is GPIO input, internal pull-low)<br>SD card data bus line 0 input/output.                                |
| 9       | SD_CD/GPIO25           | I/O  | GPIO25 input/output. (By default is GPIO input, internal pull-low)<br>SD card detect input.                                                |
| 10      | SD_WP/GPIO26           | I/O  | GPIO26 input/output. (By default is GPIO input, internal pull-low)<br>SD card write protection input.                                      |
| 11      | SPIM_CLK/GPIO27        | I/O  | GPIO27 input/output. (By default is GPIO input, internal pull-low)<br>Serial clock output for SPI master.                                  |
| 12      | SPIM_SS0/GPIO28        | I/O  | GPIO28 input/output. (By default is GPIO input, internal pull-low)<br>Slave select 0 output for SPI master.                                |
| 13      | SPIM_MOSI/GPIO29       | I/O  | GPIO29 input/output. (By default is GPIO input, internal                                                                                   |

| Pin No. | Name              | Type | Description                                                                                                                                                            |
|---------|-------------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|         |                   |      | pull-low)<br>Master out slave in for SPI master.<br>Data line 0 input/output for SPI master dual & quad mode.                                                          |
| 14      | SPIM_MISO/GPIO30  | I/O  | GPIO30 input/output. (By default is GPIO input, internal pull-low)<br>Master in slave out for SPI master.<br>Data line 1 input/output for SPI master dual & quad mode. |
| 15      | SPIM_IO2/GPIO31   | I/O  | GPIO31 input/output. (By default is GPIO input, internal pull-low)<br>Data line 2 input/output for SPI master quad mode.                                               |
| 16      | SPIM_IO3/GPIO32   | I/O  | GPIO32 input/output. (By default is GPIO input, internal pull-low)<br>Data line 3 input/output for SPI master quad mode.                                               |
| 17      | SPIM_SS1/GPIO33   | I/O  | GPIO33 input/output. (By default is GPIO input, internal pull-low)<br>Slave select 1 output for SPI master.                                                            |
| 18      | SPIM_SS2/GPIO34   | I/O  | GPIO34 input/output. (By default is GPIO input, internal pull-low)<br>Slave select 2 output for SPI master.                                                            |
| 19      | SPIM_SS3/GPIO35   | I/O  | GPIO35 input/output. (By default is GPIO input, internal pull-low)<br>Slave select 3 output for SPI master.                                                            |
| 20      | SPIS0_CLK/GPIO36  | I/O  | GPIO36 input/output. (By default is GPIO input, internal pull-low)<br>Serial clock input for SPI slave 0.                                                              |
| 21      | SPIS0_SS/GPIO37   | I/O  | GPIO37 input/output. (By default is GPIO input, internal pull-low)<br>Slave select input for SPI slave 0.                                                              |
| 22      | SPIS0_MOSI/GPIO38 | I/O  | GPIO38 input/output. (By default is GPIO input, internal pull-low)<br>Master out slave in for SPI slave 0.                                                             |
| 23      | SPIS0_MISO/GPIO39 | I/O  | GPIO39 input/output. (By default is GPIO input, internal pull-low)<br>Master in slave out for SPI slave 0.                                                             |
| 24      | SPIS1_CLK/GPIO40  | I/O  | GPIO40 input/output. (By default is GPIO input, internal pull-low)<br>Serial clock input for SPI slave 1.                                                              |
| 25      | SPIS1_SS/GPIO41   | I/O  | GPIO41 input/output. (By default is GPIO input, internal pull-low)                                                                                                     |

| Pin No. | Name              | Type | Description                                                                                                                                                              |
|---------|-------------------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|         |                   |      | Slave select input for SPI slave 1.                                                                                                                                      |
| 26      | SPIS1_MOSI/GPIO42 | I/O  | GPIO42 input/output. (By default is GPIO input, internal pull-low)<br>Master out slave in for SPI slave 1.                                                               |
| 27      | SPIS1_MISO/GPIO43 | I/O  | GPIO43 input/output. (By default is GPIO input, internal pull-low)<br>Master in slave out for SPI slave 1.                                                               |
| 28      | I2C0_SCL/GPIO44   | I/O  | GPIO44 input/output. (By default is GPIO input, internal pull-low)<br>I <sup>2</sup> C 0 serial clock input/output. (By default is I <sup>2</sup> C 0 master)            |
| 29      | I2C0_SDA/GPIO45   | I/O  | GPIO45 input/output. (By default is GPIO input, internal pull-low)<br>I <sup>2</sup> C 0 data line input/output. (By default is I <sup>2</sup> C 0 master)               |
| 30      | I2C1_SCL/GPIO46   | I/O  | GPIO46 input/output. (By default is GPIO input, internal pull-low)<br>I <sup>2</sup> C 1 serial clock input/output. (By default is I <sup>2</sup> C 1 slave)             |
| 31      | I2C1_SDA/GPIO47   | I/O  | GPIO47 input/output. (By default is GPIO input, internal pull-low)<br>I <sup>2</sup> C 1 data line input/output. (By default is I <sup>2</sup> C 1 slave)                |
| 32      | VCC1V2            | P    | +1.2V Regulator power supply for PLL.<br>Provide +1.2V power to this pin. This pin must be connected to pin 63. Connect 0.1uF decoupling capacitor.                      |
| 33      | VCCIO3V3          | P    | +3.3V supply voltage.<br>This is the supply voltage for all the I/O ports. Connect a 0.1uF decoupling capacitor to GND. This pin must be connected to pin 46 and pin 64. |
| 34      | RESETN            | I    | Chip reset input for normal operation. Active low.<br>Connect external 10kΩ pull-up to VCC3V3 for safe operation.                                                        |
| 35      | STESTRESETN       | I    | Chip reset input for test mode.<br>Connect this pin to Ground via a 10kΩ resistor for normal operation.                                                                  |
| 36      | DEBUG             | I/O  | One-wire debugger interface input/output. By default, this pin is pull-up with 75KΩ.                                                                                     |
| 37      | UART0_TXD/GPIO48  | I/O  | GPIO48 input/output. (By default is GPIO input, internal pull-low)<br>Transmitter output for UART0.                                                                      |
| 38      | UART0_RXD/GPIO49  | I/O  | GPIO49 input/output. (By default is GPIO input, internal pull-low)                                                                                                       |

| Pin No. | Name                                | Type | Description                                                                                                                                                                      |
|---------|-------------------------------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|         |                                     |      | Receiver input for UART0.                                                                                                                                                        |
| 39      | UART0_RTS/GPIO50                    | I/O  | GPIO50 input/output. (By default is GPIO input, internal pull-low)<br>Request to send output for UART0.                                                                          |
| 40      | UART0_CTS/GPIO51                    | I/O  | GPIO51 input/output. (By default is GPIO input, internal pull-low)<br>Clear to send input for UART0.                                                                             |
| 41      | UART0_DTR/UART1_TXD/<br>PWM4/GPIO52 | I/O  | GPIO52 input/output. (By default is GPIO input, internal pull-low)<br>PWM channel 4, output.<br>Transmitter output for UART1.<br>Data terminal ready output for UART0.           |
| 42      | UART0_DSR/UART1_RXD/<br>PWM5/GPIO53 | I/O  | GPIO53 input/output. (By default is GPIO input, internal pull-low)<br>PWM channel 5, output.<br>Receiver input for UART1.<br>Data set ready input for UART0.                     |
| 43      | UART0_DCD/UART1_RTS/<br>PWM6/GPIO54 | I/O  | GPIO54 input/output. (By default is GPIO input, internal pull-low)<br>PWM channel 6, output.<br>Request to send output for UART1.<br>Data carrier detection input for UART0.     |
| 44      | UART0_RI/UART1_CTS/<br>PWM7/GPIO55  | I/O  | GPIO55 input/output. (By default is GPIO input, internal pull-low)<br>PWM channel 7, output.<br>Clear to send input for UART1.<br>Ring indicator input for UART0.                |
| 45      | GND                                 | P    | Ground                                                                                                                                                                           |
| 46      | VCCIO3V3                            | P    | +3.3V supply voltage.<br>This is the supply voltage for all the I/O ports. Connect 10uF and 0.1uF decoupling capacitors to GND. This pin must be connected to pin 33 and pin 64. |
| 47      | PWM0/GPIO56                         | I/O  | GPIO56 input/output. (By default is GPIO input, internal pull-low)<br>PWM channel 0, output.<br>A stereo 16/8-bit PCM audio data channel output.                                 |
| 48      | PWM1/GPIO57                         | I/O  | GPIO57 input/output. (By default is GPIO input, internal pull-low)<br>PWM channel 1, output.                                                                                     |

| Pin No. | Name              | Type | Description                                                                                                                                                      |
|---------|-------------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|         |                   |      | A stereo 16/8-bit PCM audio data channel output.                                                                                                                 |
| 49      | PWM2/GPIO58       | I/O  | GPIO58 input/output. (By default is GPIO input, internal pull-low)<br>PWM channel 2, output.                                                                     |
| 50      | I2S_SDAO/GPIO60   | I/O  | GPIO60 input/output. (By default is GPIO input, internal pull-low)<br>Serial data line output for I2S master or slave.                                           |
| 51      | I2S_SDAI/GPIO61   | I/O  | GPIO61 input/output. (By default is GPIO input, internal pull-low)<br>Serial data line input for I2S master or slave.                                            |
| 52      | I2S_BCLK/GPIO62   | I/O  | GPIO62 input/output. (By default is GPIO input, internal pull-low)<br>Bit clock line output for I2S master transmitter or input for I2S slave receiver.          |
| 53      | I2S_LRCLK/GPIO63  | I/O  | GPIO63 input/output. (By default is GPIO input, internal pull-low)<br>Left / Right clock line output for I2S master transmitter or input for I2S slave receiver. |
| 54      | I2S_MCLK/GPIO64   | I/O  | GPIO64 input/output. (By default is GPIO input, internal pull-low)<br>I2S master transmitter clock output.                                                       |
| 55      | I2SM_CLK22/GPIO65 | I/O  | GPIO65 input/output. (By default is GPIO input, internal pull-low)<br>I2S master external 22.5792MHz clock input.                                                |
| 56      | I2SM_CLK24/GPIO66 | I/O  | GPIO66 input/output. (By default is GPIO input, internal pull-low)<br>I2S master external 24.576MHz clock input.                                                 |
| 57      | VBUS_DISCHG/GPIO0 | I/O  | GPIO0 input/output. (By default is GPIO input, internal pull-high)<br>USB host VBUS discharge.                                                                   |
| 58      | OC_N/GPIO1        | I/O  | GPIO1 input/output. (By default is GPIO input, internal pull-high)<br>USB host port over current status output. Active low.                                      |
| 59      | PSW_N/GPIO2       | I/O  | GPIO2 input/output. (By default is GPIO input, internal pull-high)<br>USB host port external VBUS power switcher. Active low.                                    |
| 60      | VBUS_DTC/GPIO3    | I/O  | GPIO3 input/output. (By default is GPIO input, internal pull-low)<br>USB device VBUS detection.                                                                  |

| Pin No. | Name            | Type | Description                                                                                                                                                                                                             |
|---------|-----------------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 61      | ENET_LED0/GPIO4 | I/O  | GPIO4 input/output. (By default is GPIO input, internal pull-low)<br>Ethernet activity indicator LED 0. <a href="#">[2]</a>                                                                                             |
| 62      | ENET_LED1/GPIO5 | I/O  | GPIO5 input/output. (By default is GPIO input, internal pull-low)<br>Ethernet activity indicator LED 1. <a href="#">[2]</a>                                                                                             |
| 63      | VOUT1           | P    | +1.2V Regulator power output.<br>This is internal regulator output. Connect 4.7uF and 0.1uF decoupling capacitors to GND.<br>This pin must be connected to pins 32 and 67.                                              |
| 64      | VCCIO3V3        | P    | +3.3V supply voltage.<br>This is the supply voltage for all the I/O ports. Connect a 0.1uF decoupling capacitor. This pin must be connected to pin 33 and pin 46.                                                       |
| 65      | XI/CLKIN        | AI   | 12MHz clock frequency input to the Oscillator circuit or to internal clock generator circuit.                                                                                                                           |
| 66      | XIO             | AO   | Output from the Oscillator amplifier.                                                                                                                                                                                   |
| 67      | VCC1V2          | P    | +1.2V Regulator power supply for USB.<br>Provide +1.2V power to this pin. This pin must be connected to pin 63. Connect 0.1uF decoupling capacitor.                                                                     |
| 68      | VUSB3V3         | P    | +3.3V supply voltage.<br>This is the supply voltage for USB device and host I/O ports. Connect 10uF and 0.1uF decoupling capacitors. This pin could be connected to all +3.3V power supply pins without 10uF capacitor. |
| 69      | D_DM            | AI/O | USB device bidirectional DM line.                                                                                                                                                                                       |
| 70      | D_DP            | AI/O | USB device bidirectional DP line.                                                                                                                                                                                       |
| 71      | DRREF           | AI   | USB device reference voltage input.<br>Connect 12Kohm +/- 1% resistor to GND.                                                                                                                                           |
| 72      | H_DM            | AI/O | USB host bidirectional DM line.                                                                                                                                                                                         |
| 73      | H_DP            | AI/O | USB host bidirectional DP line.                                                                                                                                                                                         |
| 74      | AGND            | P    | Analog Ground                                                                                                                                                                                                           |
| 75      | HRREF           | AI   | USB host reference voltage input.<br>Connect a 12 kΩ ± 1% resistor to GND.                                                                                                                                              |
| 76      | VETH3V3         | P    | +3.3V supply voltage.<br>This is the supply voltage for Ethernet I/O ports. Connect 10uF and 0.1uF decoupling capacitors. This pin could be connected to all +3.3V power supply pins without 10uF                       |

| Pin No. | Name                            | Type | Description                                                                                                                                                                  |
|---------|---------------------------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|         |                                 |      | capacitor.                                                                                                                                                                   |
| 77      | VOUT2                           | P    | +1.2V Regulator power supply. <a href="#">[2]</a><br>This is an internal regulator output. Connect 0.1uF decoupling capacitors.                                              |
| 78      | EREFSET                         | AI   | Ethernet reference voltage input. <a href="#">[2]</a><br>Connect a 12.3 kΩ ± 1% resistor to GND.                                                                             |
| 79      | VETH3V3                         | P    | +3.3V supply voltage.<br>This is the supply voltage for Ethernet I/O ports. Connect a 0.1uF decoupling capacitor. This pin must be connected to pin 76.                      |
| 80      | RXIP                            | I    | Ethernet receive data positive input. <a href="#">[2]</a><br>Differential receive signal pair.                                                                               |
| 81      | RXIN                            | I    | Ethernet receive data negative input. <a href="#">[2]</a><br>Differential receive signal pair.                                                                               |
| 82      | TXOP                            | O    | Ethernet transmit data positive output. <a href="#">[2]</a><br>Differential transmit signal pair.                                                                            |
| 83      | TXON                            | O    | Ethernet transmit data negative output. <a href="#">[2]</a><br>Differential transmit signal pair.                                                                            |
| 84      | RTC_XIO                         | AO   | Output from the RTC Oscillator amplifier.                                                                                                                                    |
| 85      | RTC_XI/RTC_CLKIN                | AI   | 32.768-kHz clock frequency input to the RTC Oscillator circuit or to internal RTC clock generator circuit.                                                                   |
| 86      | VBAT                            | P    | +1.5V RTC supply voltage.                                                                                                                                                    |
| 87      | ADC1/RTC_REF/<br>CAM_XCLK/GPIO6 | I/O  | GPIO6 input/output. (By default is GPIO input, internal pull-low)<br>Camera external clock output.<br>Reference clock for RTC calibration.<br>10-bit A/D converter 1, input. |
| 88      | ADC2/CAM_PCLK/GPIO7             | I/O  | GPIO7 input/output. (By default is GPIO input, internal pull-low)<br>Camera pixel clock input.<br>10-bit A/D converter 2, input.                                             |
| 89      | ADC3/CAM_VD/GPIO8               | I/O  | GPIO8 input/output. (By default is GPIO input, internal pull-low)<br>Camera vertical sync input.<br>10-bit A/D converter 3, input.                                           |
| 90      | ADC4/CAM_HD/GPIO9               | I/O  | GPIO9 input/output. (By default is GPIO input, internal pull-low)                                                                                                            |

| Pin No. | Name                   | Type | Description                                                                                                                                                                                    |
|---------|------------------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|         |                        |      | Camera horizontal reference input.<br>10-bit A/D converter 4, input.                                                                                                                           |
| 91      | ADC5/CAM_D7/GPIO10     | I/O  | GPIO10 input/output. (By default is GPIO input, internal pull-low)<br>Camera data 7 input.<br>10-bit A/D converter 5, input.                                                                   |
| 92      | ADC6/CAM_D6/GPIO11     | I/O  | GPIO11 input/output. (By default is GPIO input, internal pull-low)<br>Camera data 6 input.<br>10-bit A/D converter 6, input.                                                                   |
| 93      | ADC7/CAM_D5/GPIO12     | I/O  | GPIO12 input/output. (By default is GPIO input, internal pull-low)<br>Camera data 5 input.<br>10-bit A/D converter 7, input.                                                                   |
| 94      | AGND                   | P    | Analog Ground                                                                                                                                                                                  |
| 95      | VCC3V3A                | p    | +3.3V supply voltage.<br>This is the supply voltage for Analog I/O ports. Connect 10uF and 0.1uF decoupling capacitors. This pin could be connected to all VCC3V3 pins without 10uF capacitor. |
| 96      | DAC_REFP               | I    | 10-bit DAC positive reference voltage.                                                                                                                                                         |
| 97      | DAC1/CAM_D4/GPIO13     | I/O  | GPIO13 input/output. (By default is GPIO input, internal pull-low)<br>Camera data 4 input.<br>10-bit D/A converter 1, output.                                                                  |
| 98      | DAC0/CAM_D3/GPIO14     | I/O  | GPIO14 input/output. (By default is GPIO input, internal pull-low)<br>Camera data 3 input.<br>10-bit D/A converter 0, output.                                                                  |
| 99      | CAN0_TXD/CAM_D2/GPIO15 | I/O  | GPIO15 input/output. (By default is GPIO input, internal pull-low)<br>CAN0 transmitter output. <a href="#">[1]</a><br>Camera data 2 input.                                                     |
| 100     | CAN0_RXD/CAM_D1/GPIO16 | I/O  | GPIO16 input/output. (By default is GPIO input, internal pull-low)<br>CAN0 receiver input. <a href="#">[1]</a><br>Camera data 1 input.                                                         |

**Table 3-1 - FT900 Pin Description**

[1] CAN Bus 0/1 only are featured on both FT900 and FT902 packages.

- 
- [2] Ethernet pins are available on FT900 and FT901 only. For FT902 and FT903, shall leave all Ethernet pins as NC pin floating except for pin61 and pin62 as GPIO by default.

**Notes:**

|    |                     |      |                                 |
|----|---------------------|------|---------------------------------|
| P  | : Power or ground   | I/O  | : Bi-direction Input and Output |
| I  | : Input             | AI   | : Analog Input                  |
| O  | : Output            | AO   | : Analog Output                 |
| OD | : Open drain output | AI/O | : Analog Input / Output         |

## 4 Function Description

### 4.1 Architectural Overview

The FT900/1/2/3 series embedded microcontrollers include a high performance 32-bit FT32 RISC core processor and 256kB hi-speed Flash memory for software program downloading with a One-Wire debugger interface. The core processor uses a 32-bit I/O system bus to connect to all of the peripherals.

- 32-bit MCU Processor Core
- 256kB Flash Memory
- 256kB Shadow Program Memory
- 64kB Data Memory
- USB2.0 host controller with battery charging capability
- USB2.0 device controller with battery charging detection capability
- 10/100Mbps Ethernet controller (*FT900 and FT901 only*)
- Two CAN bus interfaces (*FT900 and FT902 only*)
- Real Time Clock
- One-Wire debugger interface
- One SPI master interface and two SPI slave interfaces
- One I<sup>2</sup>C master and one I<sup>2</sup>C slave interface
- One I<sup>2</sup>S bus interface
- Two programmable 8Mbit/s UARTs
- Four 16-bit timers and one 32-bit watchdog timer
- Camera parallel interface
- SD host controller
- 8-Channel PWM with optional 2-Channel Audio PCM
- 10-bit two channel 1 MS/s DAC
- Configurable 8-bit/10-bit seven channel 480/960 kS/s ADC
- General purpose I/O interface

The functions for each controller / interface are briefly described in the following subsections.

### 4.2 FT32 Core Processor

The FT32 core processor is running at frequencies of up to 100MHz. The processor contains the CPU itself with control logic and its 256kB program memory and 64kB data memory. The outside connections for the core processor are the memory-mapped I/O interface, the interrupt interface, asynchronous reset and the system clock.

### 4.3 256kB Flash Memory

The internal 256kB Flash memory is used to store a boot loader or user application of the FT900/1/2/3 series. It is a high performance and low power consumption memory that supports up to 80MHz serial clock. The system will perform memory copy from Flash memory to CPU program memory automatically after system power on.

### 4.4 Boot Sequence

After the initial memory copy completes, the CPU jumps to program memory location zero. This may be the start of the user application which is stored in advance in Flash memory, or a boot loader only which allows program memory to perform modification via (e.g.) UART or USB.

The option of a boot loader is a special purpose routine in the FT900/1/2/3 series embedded microcontroller. It is a small routine stored in the Flash memory. Typically the boot loader is 1-4kbytes in size, and is loaded at the top of the available memory.

## 4.5 Interrupt

The FT900/1/2/3 interrupt controller handles 32 interrupt inputs. When an interrupt occurred, the Interrupt Service Route (ISR) will process this event via the CPU. The ISR vector range is from 0 to 31, which corresponds to interrupt 0 to 31. See Table 4-1 information.

Each interrupt shall be assigned the interrupt vector number and priority before use. By default, the highest priority interrupt is interrupt 0, and the lowest is interrupt 31. However, the interrupt priority can be rearranged by register settings and also allows multiple interrupts at the same priority.

To prevent the loss and delay of high priority interrupts, the FT900/1/2/3 series uses nested interrupts if enabled. Nested interrupts allow interrupt requests of a high priority to pre-empt interrupt requests of a lower priority. FT900/1/2/3 series supports up to 16-levels deep of nested interrupts.

The interrupt controller has a global interrupt mask bit to temporarily block all interrupts. If this bit is set to "1", then with the exception of an interrupt assigned priority as "0", which is a non-maskable interrupt (NMI) input, all interrupts are masked.

See Table 4-1 for FT900/1/2/3 series default interrupt priority.

| Peripherals of Interrupt     | Interrupt Vector Index | Default Priority |
|------------------------------|------------------------|------------------|
| Power Management             | 0                      | 0 (NMI)          |
| USB2.0 Host Controller       | 1                      | 1                |
| USB2.0 Peripheral Controller | 2                      | 2                |
| Ethernet Controller          | 3                      | 3                |
| SD Host Controller           | 4                      | 4                |
| CAN Bus 0                    | 5                      | 5                |
| CAN Bus 1                    | 6                      | 6                |
| Camera                       | 7                      | 7                |
| SPI Master                   | 8                      | 8                |
| SPI Slave 0                  | 9                      | 9                |
| SPI Slave 1                  | 10                     | 10               |
| I <sup>2</sup> C 0           | 11                     | 11               |
| I <sup>2</sup> C 1           | 12                     | 12               |
| UART 0                       | 13                     | 13               |
| UART 1                       | 14                     | 14               |
| I <sup>2</sup> S Bus         | 15                     | 15               |
| PWM                          | 16                     | 16               |
| Timers                       | 17                     | 17               |
| GPIO                         | 18                     | 18               |
| RTC                          | 19                     | 19               |

| Peripherals of Interrupt | Interrupt Vector Index | Default Priority |
|--------------------------|------------------------|------------------|
| ADC                      | 20                     | 20               |
| DAC                      | 21                     | 21               |
| Slow Clock Timer         | 22                     | 22               |
| <b>UNUSED</b>            | <b>23-31</b>           | <b>23-31</b>     |

**Table 4-1 - FT900/1/2/3 Series Default Interrupt Priority**

## 4.6 Memory Mapping

A list of the I/O memory mapping for registers and memory in the FT900/1/2/3 series is given below in table 4-2. Please refer to [FT900 User Manual](#) for detail description of registers.

| Function                                               | Address Memory Range |         | Comment                         |
|--------------------------------------------------------|----------------------|---------|---------------------------------|
| General setup registers                                | 0x10000              | 0x100BF | DW/W/B                          |
| Interrupt controller registers                         | 0x100C0              | 0x100FF | DW/W/B                          |
| USB2.0 host controller registers                       | 0x10100              | 0x1017F | DW/W/B                          |
| USB2.0 host controller RAM memory                      | 0x11000              | 0x12FFF | DW/W/B                          |
| USB2.0 device controller registers                     | 0x10180              | 0x1021F | DW/W/B                          |
| USB2.0 device registers for high-bandwidth isochronous | 0x10A1C              | 0x10A33 | DW/W/B                          |
| Ethernet controller registers                          | 0x10220              | 0x1023F | DW/W/B (Uses DW to access FIFO) |
| CAN BUS 0 registers                                    | 0x10240              | 0x1025F | B                               |
| CAN BUS 1 registers                                    | 0x10260              | 0x1027F | B                               |
| RTC registers                                          | 0x10900              | 0x1093F | DW                              |
| SPI master registers                                   | 0x102A0              | 0x102BF | DW                              |
| SPI Master (extended)                                  | 0x10940              | 0x1095F | DW                              |
| SPI slave 0 registers                                  | 0x102C0              | 0x102DF | DW                              |
| SPI slave 0 (extended)                                 | 0x10960              | 0x1097F | DW                              |
| SPI slave 1 registers                                  | 0x102E0              | 0x102FF | DW                              |
| SPI slave 1 (extended)                                 | 0x10980              | 0x1099F | DW                              |
| I <sup>2</sup> C master registers                      | 0x10300              | 0x1030F | B                               |
| I <sup>2</sup> C slave registers                       | 0x10310              | 0x1031F | B                               |

| Function                                   | Address Memory Range |         | Comment                               |
|--------------------------------------------|----------------------|---------|---------------------------------------|
| UART 0 register                            | 0x10320              | 0x1032F | B                                     |
| UART 1 registers                           | 0x10330              | 0x1033F | B                                     |
| Timers (include Watchdog) registers        | 0x10340              | 0x1034F | B                                     |
| I <sup>2</sup> S master or slave registers | 0x10350              | 0x1035F | W                                     |
| Camera registers                           | 0x10360              | 0x1036F | DW                                    |
| Reserved                                   | 0x10370              | 0x103BF | -                                     |
| PWM registers                              | 0x103C0              | 0x103FF | Registers: B access<br>FIFO: W access |
| SD host controller registers               | 0x10400              | 0x107FF | DW                                    |
| Flash controller registers                 | 0x10800              | 0x108BF | B                                     |
| Reserved                                   | 0x108C0              | 0x10FFF | -                                     |

**Table 4-2 - FT900/1/2/3 Series I/O Memory Mapping**

**Notes:** DW / W / B are length of register operation.

DW: Double Word (32-bit)      W: Word (16-bit)    B: Byte (8-bit)

## 4.7 USB2.0 Host Controller

The Hi-Speed USB2.0 single-port host controller is compliant with the USB2.0 specification and the Enhanced Host Controller Interface (EHCI) specification. There is an option to enable a downstream port with a Battery Charging (BC) feature, which can be configured as Standard Downstream Port (SDP), or Charging Downstream Port (CDP), or Dedicated Charging Port (DCP). The battery charging feature is compatible with the [Battery Charging Specification Revision 1.2 \(BC 1.2\)](#) by USB-IF.

### 4.7.1 Features

- Compliant with the USB specification revision 2.0.
- Compliant with EHCI specification revision 1.0.
- The USB1.1 host is integrated into the USB2.0 EHCI compatible host controller.
- Supports data transfer at hi-speed (480 Mb/s), full-speed (12 Mb/s) and low-speed (1.5 Mb/s).
- Supports the split transaction for hi-speed Hubs and the preamble transaction full-speed hubs.
- Supports the Isochronous/Interrupt/Control/Bulk data transfers.
- 8kB high speed RAM memory integrated.
- Supports Battery Charging specification revision 1.2.
- Supports VBUS power switching and over current control.

## 4.8 USB2.0 Device Controller

The USB 2.0 device controller is fully compliant with the USB2.0 specification. There is also an option to enable a battery charger detection (BCD) feature on the upstream port, which can identify whether the connected downstream port supports SDP, CDP or DCP charging function. Battery charge detection allows the USB device to determine if higher currents may be available from the USB connection for rapid battery charging.

### 4.8.1 Features

- Supports data transfer at hi-speed (480 Mb/s) and full-speed (12 Mb/s).
- Software configurable EP0 control endpoint size 8-64 bytes
- Software configurable 7 IN/OUT endpoints.
- EP1-EP7 has double buffering which contains 2kB IN and 2kB OUT buffers.
- Supports the Isochronous/Interrupt/Control/Bulk data transfers.
- Supports high-bandwidth isochronous IN transaction
- Max endpoint packet sizes upon 1024 bytes.
- Supports VBUS detection.
- Supports suspend and resume power management functions.
- Supports remote wakeup feature.
- Supports Battery Charging specification revision 1.2.

## 4.9 Ethernet Controller

The Ethernet controller contains an on-chip 10/100BASE-TX Ethernet transceiver and Media Access Control (MAC) designed to provide high performance of frame transmission and reception. The Ethernet transceiver is compliant with 10/100BASE-TX Ethernet standards, such as IEEE802.3/802.3u and ANSI X3.263-1995, and MAC protocol refers to an IEEE standard 802.3-2000.

### 4.9.1 Features

- 10/100 Mbps data transfer.
- Conforms to IEEE 802.3-2002 specification.
- Supports full-duplex and half-duplex modes.
  - Supports CSMA/CD protocol for half-duplex operation.
  - Supports IEEE802.3x flow control for full-duplex operation.
- Programmable MAC address.
- CRC-32 algorithm calculates the FCS nibble at a time, automatic FCS generation and checking, able to capture frames with CRC errors if required.
- Promiscuous mode support.
- Station Management (STA) entity included.
- Supports double buffering for 2kB TX and 4kB RX memory.
- Two LED indicators used by Ethernet multi-function.

## 4.10 CAN Bus Controller

The FT900/1/2/3 series contains two CAN controllers, CAN0 and CAN1. Controller Area Network (CAN) is a high performance communication protocol for serial data communication. It is widely used in automotive and industrial applications. However this is expanding due to its reliability and feasibility. CAN bus use a multi-master bus scheme with one logic bus line and equal nodes. The number of nodes is not limited by the protocol. Nodes do not have specific addresses. Instead, message identifiers are used, indicating the message content and priority of the message. FT900 CAN bus controllers support multicasting and broadcasting with an external CAN transceiver.

### 4.10.1 Features

- Conforms to protocol version 2.0 parts A and B.
- Supports bit rates of up to 1 Mb/s.
- Supports standard (11-bit identifier) and extended (29-bit identifier) frames.
- Support hardware message filtering with dual/single filters.
- 64 Bytes receiver and 16 Bytes transmitter FIFO.
- No overload frames are generated.
- Supports normal and listen-only modes.

- Supports single shot transmission.
- Supports an abort transmission feature.
- Readable error counters and last error code capture supported.

## 4.11 Real Time Clock

The Real Time Clock (RTC) runs off a dedicated 32.768 kHz oscillator with its own power rail which can be connected to a separate battery via the VBAT pin.

### 4.11.1 Features

- Built-in Clock Stabilizer for the 32.768 kHz input
- Records system sleep time
- Supports Date and Time format in BCD
- Counts Second, Minute, Hour, Day, Date of the Month, Month and Year with Leap-Year Compensation Valid up to 2199
- Supports two configurable Time-of-Day Alarms
- Supports interrupt for two configurable alarm events
- Supports On-Chip Digital Trimming with Auto Calibration

## 4.12 One-Wire Debugger Interface

The Debugger interface provides the capability, over a One-Wire half duplex serial link, to access memory mapped address space, such as the FT900 Flash memory, program memory, data memory and I/O memory. However, there is no transfer capability from any of the internal memory to the debugger interface.

### 4.12.1 Features

- Single wire half duplex link that has one Start, eight Data and one Stop bits at a 1M bit/s rate.
- Supports debugger command read / write operation with variable data transfer.
- Supports CHIP ID read out.
- Supports checksum check by Flash memory operation.
- Supports CPU software debugging to execute Run, Stop, Step, Halt, Set software breakpoint, etc. operations.
- Use semaphore flag to control resource allocated by CPU or Debugger.

## 4.13 SPI Interface

The FT900/1/2/3 series contains an SPI master and SPI0, SPI1 slave controllers. SPI is a full duplex serial interface designed to handle multiple masters and slaves connected to a given bus.

### 4.13.1 Features

- Maximum SPI data bit rate 50MHz in master and 25MHz in slave modes.
- Full duplex synchronous serial data transfer.
- Compliant with SPI specification, support four transfer formats.
- SPI master supports Single, Dual and Quad SPI transfer.
- SPI0, SPI1 slave support Single transfer only.
- Support SPI mode and FIFO mode operations.
- Multi-master system supported.
- Support bus error detection.
- SPI master can address up to 4 SPI slave devices.
- Support 16/64 Bytes receiver and 16/64 Bytes transmitter FIFO respectively.

## 4.14 I<sup>2</sup>C Interface

The FT900/1/2/3 series supports an I<sup>2</sup>C bus controller which is a bidirectional two wire interface. The two wires are Serial Clock line (SCL) and Serial Data line (SDA). The interface can be programmed to operate with arbitration and clock synchronization allowing it to operate in multi-master systems. I<sup>2</sup>C0 and I<sup>2</sup>C1 support transmission speed up to 3.4Mb/s.

### 4.14.1 Features

- Conforms to v2.1 and v3.0 of the I<sup>2</sup>C specification.
  - UM10204 I<sup>2</sup>C-bus specification and user manual Rev. 6 – 4 April 2014
- Support flexible transmission speed modes:
  - Standard (up to 100 kb/s)
  - Fast (up to 400 kb/s)
  - Fast-plus (up to 1 Mb/s)
  - High-speed (up to 3.4 Mb/s)
- One I<sup>2</sup>C Master and one I<sup>2</sup>C Slave interface with switchable pins are available.
- Perform arbitration and clock synchronization.
- Multi-master systems supported.
- Support both 7-bit and 10-bit addressing modes on the I<sup>2</sup>C bus.
- Support clock stretching.

## 4.15 UART Interface

The FT900/1/2/3 series contains two UART controllers with standard transmit and receive data lines. UART0 provides a full modem control handshake interface and support for 9-bit data, allowing automatic address detection while 9-bit data mode is enabled.

UART1 is a simplified programmable serial interface with CTS and RTS flow control logic. The signals are multiplexed with UART0 and can only be used if UART0 is used in simple mode (CTS/RTS only).

### 4.15.1 Features

- Maximum UART data bit rate of 8 Mb/s.
- Support UART mode and FIFO mode operation.
- 16 / 128 bytes FIFO for TX and RX in FIFO mode to reduce the interrupt frequency.
- Software compatible with 16450, 16550, 16750 and 16950 industry standard.
- Modem control function (CTS, RTS, DSR, DTR, RI, and DCD) support for UART0.
- Programmable automatic out-of- band flow control logic through Auto-RTS and Auto-CTS.
- Programmable automatic flow control logic using DTR and DSR.
- Programmable automatic in-band flow control logic using XON/XOFF characters.
- Support external RS-485 buffer enable.
- Fully programmable serial interface characteristics:
  - 5-, 6-, 7-, 8-, or 9-bit data characters
  - Even, Odd, or No-parity bit generation and detection
  - 1-, 1.5- or 2-stop bit generation
  - Baud rate generation
  - Detection of bad data in Receive FIFO
- Support Transmitter and Receiver disable capability.

## 4.16 Timers and Watchdog Timer

The FT900/1/2/3 series has four 16-bit user timers with individual pre-scaler and a 32-bit watchdog feature.

The watchdog timer is controlled from the main clock. The watchdog can be initialized with a 5-bit register. The value of this register points to a bit of the 32-bit counter which will be set by the application

firmware. As the timer decrements, an interrupt occurs when the timer rolls over. Once started and initialized the watchdog can't be stopped. It can only be cleared by writing into a register.

The four user timers can be controlled from the main clock, each timer has its own 16-bit pre-scaler. These timers can be started, stopped and cleared / initialized. The pre-scalers can be cleared or initialised the same way.

The current value of all timers/pre-scalers can be read from a common register one-at-a-time (multiplexed access).

All timers can count up/down and signal an interrupt when the timer rolls over. The timers can also be configured to be one-shot or in continuous mode. They are initialised from a common register one-at-a-time (multiplexed access).

If the user timer has already started using its pre-scaler, it cannot be cleared and the command is ignored. Each of the pre-scalers automatically stops after it is cleared individually. It also starts automatically when the corresponding user timer starts using it.

#### **4.16.1 Features**

- Four user timers with individual pre-scaler.
- Supports 16-bit pre-scaler with system clock reference.
- Supports individual timer interrupt generated.
- Supports one-shot and continuous count for timer.
- Supports 32-bit counter watchdog.
- Supports watchdog interrupt generated.

### **4.17 I<sup>2</sup>S Interface**

The FT900 I<sup>2</sup>S interface supports both Master and Slave modes. The formats supported are I<sup>2</sup>S, Left Justified and Right Justified.

In Master mode, two clock sources are to be provided externally. One is 24.576MHz and the other is 22.5792MHz. The LRCLK, BCLK and MCLK as output signals will be generated by the Master based on sampling rate and data bit length.

In Slave mode, the LRCLK and BCLK are input signals to the FT900. The MCLK source is not used in this case. The application can configure the two clock source pins (I2SM\_CLK22, I2SM\_CLK24) to GPIO operation.

#### **4.17.1 Features**

- Configure I<sup>2</sup>S interface as master or slave.
- Support I<sup>2</sup>S, Left Justified and Right Justified format.
- Support different sample rates: 11.025 kHz, 22.050 kHz, 44.1 kHz, 16 kHz, 32 kHz, 48 kHz, 96 kHz, 192 kHz and 384 kHz.
- Support different audio data bit length: 16 bits, 20 bits, 24 bits and 32 bits.
- 2kB FIFO for I<sup>2</sup>S receiver and 2kB FIFO for transfer audio data.
- Support FIFO flow control.
- Support master clock sources: 24.576MHz and 22.5792MHz.

### **4.18 Camera Parallel Interface (Data Capture)**

The Camera Parallel Interface (CPI) implements an 8-bit parallel link from an image sensor to the FT900. The interface will provide a clock to the external camera module at a Max rate of 25MHz.

Camera control signals are VSYNC, HREF and PCLK. The VSYNC signal determines when a new frame begins. The HREF signal represents the period of data transfer of a row in the transmitted frame. When the HREF signal is active, there is valid data over the data lines every pixel clock (PCLK) cycle. The PCLK signal indicates a valid data byte over the data lines and it is used as a transfer trigger.

### **4.18.1 Features**

- Configure camera registers via I<sup>2</sup>C two-wire interface.
- 8-bit data is clocked by an external clock provided by the camera module.
- With VSYNC, HREF and PCLK control signals.
- Programmable data capture trigger position.
- 2kB FIFO for camera capture data.

## **4.19 PWM**

The FT900/1/2/3 series supports 7 separate independent PWM output channels. All channels share an 8-bit pre-scaler to scale the system clock frequency to the desired channels.

Each channel has its own 16-bit comparator value. This is the value that would be matched to a preset 16-bit counter. When a channel's 16-bit comparator value matches that of the 16-bit counter, the corresponding PWM channel output will toggle. This 16-bit comparator value will continue to count until it reaches its preset value, and the counter will just roll over.

A special feature allows the 7 channels each to also toggle its own output based on the comparison results of other channels. Hence each channel potentially can have up to 8 toggle edges. The PWM signal generated can be output as a single-shot or continuous output.

The PWM counter also supports an external trigger. There are 6 GPIOs selectable for an external trigger.

PWM channel 0 and channel 1 can double as a stereo 11.025 kHz or 22.050 kHz PCM audio channel. Once this feature is setup, the 16-bit or 8-bit PCM audio data can be downloaded to the PWM local FIFO which can hold up to 64 bytes stereo or 128 bytes mono audio data. The data is played back based on the pre-scaler and 16-bit counter, and is automatically scaled to fit in the playback period if necessary.

The PWM FIFO can generate a number of interrupts to support PCM playback. They are FIFO empty, full, half-full, overflow, and underflow. Each of these interrupts can be individually masked if required.

### **4.19.1 Features**

- Support 7 PWM output channels.
- Support single-shot or continuous PWM data output.
- Support external GPIO trigger.
- Support 16-bit / 8-bit stereo PCM audio data output.
- Control PCM FIFO full, empty, half-empty, overflow and underflow buffer management.
- Support PCM volume control for audio playback.

## **4.20 SD host controller**

The FT900/1/2/3 series contains one SD host controller offering access to external large capacity non-volatile memory.

### **4.20.1 Features**

- Compliant with SD host controller standard specification, version 3.0.
- Compliant with SD physical layer specification, version 3.0. Compliant with SDIO card specification, version 2.0.
- Compliant with MMC card specification, version 4.3.
- Supports both streaming and non-streaming data transfers.
- Supports configurable SD bus modes: 1-bit mode and 4-bit mode.
- Support 4K SRAM for data FIFO.
- Configurable CPRM function for security.
- Built-in generation and check for 7-bit and 16-bit CRC data.
- Card detection (Insertion/Removal).
- Supports Read Wait mechanism for SDIO function.

## 4.21 Analog to Digital Converter (ADC)

The FT900/1/2/3 series has a low-power, high-speed, successive approximation Analog-to-Digital Converter (ADC) that supports a configurable 8-bit/10-bit resolution and superior maximum sampling frequencies of up to approximately 960 Kilo Samples Per-second (kS/s). This ADC accepts analog inputs ranging from the ground supplies to the power supplies. This ADC can be used in various low-power and medium-resolution applications.

### 4.21.1 Features

- Configurable 8-bit/10-bit successive approximation ADC.
- Supports 7 channel input.
- Individual channels can be selected for conversion.
- Power-down mode support.
- Max conversion rate up to approximately 960 kS/s.
- Measurement range 0 to VCC3V3A, by default the range voltage is 10% off of VCC3V3A. See Table 5-7.
- INL: +/-2LSB (max)..
- DNL: +/-1LSB (max).

## 4.22 Digital to Analog Converter (DAC)

The FT900/1/2/3 series has two 10-bit, 1 Mega Samples Per-second (MS/S) Digital-Analog converter (DAC). It includes digital logic for registering the DAC value and a unity-gain buffer capable of driving off-chip. The module can also be switched to a power-down state where it consumes a minimum amount of current. The maximum output value of the DAC is decided by the reference voltage at pin DAC\_REFP.

### 4.22.1 Features

- Two 10-bit DACs (0/1).
- 10-bit R-2R DAC ladder structure.
- Buffered output.
- Power-down mode support.
- Programmable conversion rate, the maximum rate is 1MHz.
- Selectable output drive.
- INL: +/-2LSB (max).
- DNL: +/-1LSB (max).

## 4.23 General Purpose Input/Output

The FT900/1/2/3 series provides up to 65 configurable Input/Output pins controlled by GPIO registers. All pins have multiple functions with special peripheral connection. Separate registers allow setting or clearing any number of outputs simultaneously. All GPIO pins default to inputs with pull-down resistors enabled on reset except GPIO0/1/2 inputs that have pull-up resistors enabled.

All GPIOs can function as an interrupt. The polarity can be either positive edge or negative edge if its interrupt capability is enabled. In this case, the GPIO pin must be configured as a GPIO input.

### 4.23.1 Features

- All GPIO default to inputs after reset (except GPIO0/1/2).
- Multi-function selection on GPIO pins.
- Pull-up/Pull-down resistor configuration and open-drain configuration can be programmed through the pin connect block for each GPIO pin.
- Direction control of individual bits.
- Supports GPIO input Schmitt trigger to help remove noise.
- Supports GPIO interrupt, where each enabled GPIO interrupt can be used to wake-up the system from power-down mode.

## 4.24 System Clocks

### 4.24.1 12 MHz Oscillator

The oscillator generates a 12 MHz reference frequency output to the clock multiplier PLL. The oscillator clock source comes from either an external 12 MHz crystal or a 12 MHz square wave clock. The external crystal is connected across XI/CLKIN and XIO in the configuration shown in Section [6.1](#). The optional external clock input is connected to XI/CLKIN only.

### 4.24.2 Phase Locked Loop

The internal PLL takes a 12 MHz clock input from a crystal oscillator. The PLL outputs the 100 MHz system clock frequency to the CPU processor and other peripheral circuits. Each peripheral has an individual enable control signal to gate the clock source.

### 4.24.3 32.768 KHz RTC Oscillator

The RTC oscillator provides a clock to the RTC time counter. Either an external 32.768 kHz crystal or a 32.768 kHz square wave clock can be used as the clock source. The external crystal is connected across RTC\_XI/RTC\_CLKIN and RTC\_XIO in the configuration shown in Section [6.2](#). The optional external clock input is connected to RTC\_XI/RTC\_CLKIN only.

### 4.24.4 Internal Slow Clock Oscillator

The internal slow clock oscillator provides at least 5ms slow clock source to generate an interrupt for the USB 2.0 device remote wake-up feature. A USB 2.0 device with remote wake-up capability may not generate resume signalling unless the bus has been continuously in the idle state for 5ms. The detail description for USB 2.0 suspend/resume, please refer to [USB 2.0 specification](#) chapters 7.1.7.6 and 7.1.7.7.

## 4.25 Power Management

### 4.25.1 Power Supply

The FT900/1/2/3 series may be operated with a single supply of +3.3V applied to VCCIO3V3, VUSB3V3, VETH3V3 and VCC3V3A pins. The +1.2V internal regulator VOUT1 provides power to the core circuit after VCCIO3V3 power on and the system will generate a Power on Reset (POR) pulse when the output voltage rises above the POR threshold. VOUT1 also provides power to the internal PLL.

The second +1.2V internal regulator VOUT2 will provide the power to the Ethernet transceiver when VETH3V3 gets the power supply.

### 4.25.2 Power Down Mode

Power down mode applies to the entire system. In the power down mode, the system 12-MHz oscillator and PLL both switch off and the system clock to the core and all peripherals stop except for the RTC oscillator and internal regulator. The internal regulator retains the power for the core and RTC running.

An interrupt from GPIO or wake-up events from the USB 2.0 device controller and host controller can wake-up the system from the power down mode independently.

If the USB 2.0 host controller was used and the respective interrupt bit enabled before the system entered into power down mode, then the following events can wake-up the system.

- Remote wake-up interrupt to USB 2.0 host controller.
- USB device connected interrupt to USB 2.0 host controller.
- USB device disconnected interrupt to USB 2.0 host controller.

- USB host controller detected the over-current (OC) protection event.

If the USB 2.0 device controller was used and the respective interrupt bit was also enabled before the system entered into power down mode, then the following events can wake-up the system.

- USB 2.0 device controller detects connect interrupt.
- USB 2.0 device controller detects disconnect interrupt.
- USB host issue reset signal to USB 2.0 device controller.
- USB host issue resume signal to USB 2.0 device controller.

## 5 Devices Characteristics and Ratings

### 5.1 Absolute Maximum Ratings

The absolute maximum ratings for the FT900/1/2/3 series devices are as follows. These are in accordance with the Absolute Maximum Rating System (IEC 60134). Exceeding these may cause permanent damage to the device.

| Parameter                                                                    | Value                                                         | Unit  |
|------------------------------------------------------------------------------|---------------------------------------------------------------|-------|
| Storage Temperature                                                          | -65 to +150                                                   | °C    |
| Floor Life (Out of Bag) At Factory Ambient<br>(30°C / 60% Relative Humidity) | 168 Hours<br>(IPC/JEDEC J-STD-033A MSL Level 3<br>Compliant)* | Hours |
| Ambient Temperature (Power Applied)                                          | -40 to +85                                                    | °C    |
| VCC3V3 Supply Voltage                                                        | -0.5 to +4.6                                                  | V     |
| DC Input Voltage – Host H_DP and H_DM                                        | -0.5 to +5                                                    | V     |
| DC Input Voltage – Peripheral D_DP and<br>D_DM                               | -0.5 to +5                                                    | V     |
| DC Input Voltage – Ethernet TXON, TXOP,<br>RXIN and RXIP                     | -0.5 to +5.6                                                  | V     |
| DC Input Voltage – 5V tolerance I/O cells                                    | -0.5 to +5.8                                                  | V     |
| Others (ADC, DAC) – 3V I/O cells                                             | -0.5 to VCC3V3+0.5                                            | V     |

**Table 5-1 - Absolute Maximum Ratings**

**Note:** If devices are stored out of the packaging beyond this time limit the devices should be baked before use. The devices should be ramped up to a temperature of +125°C and baked for up to 17 hours.

## 5.2 DC Characteristics

**Electrical Characteristics** (Ambient Temperature = -40°C to +85°C)

The typical values are obtained at room temperature ( $T_j = 25^\circ\text{C}$ ),  $V_{CC3V3} = 3.3\text{V}$ , and  $V_{CC1V2} = 1.2\text{V}$ .

| Parameter     | Description                  | Minimum | Typical | Maximum | Units         | Conditions                                         |
|---------------|------------------------------|---------|---------|---------|---------------|----------------------------------------------------|
| $V_{CCIO3V3}$ | I/O operating supply voltage | 2.97    | 3.3     | 3.63    | V             | Normal Operation                                   |
| $I_{CC1}$     | Power down current           | -       | 700     | -       | $\mu\text{A}$ | Power Down Mode                                    |
| $I_{CC2}$     | Idle current                 | -       | 42      | -       | mA            | Idle                                               |
| $I_{CC3}$     | System operating current*    | -       | 75      | -       | mA            | USB 2.0 Host controller high speed transfer data   |
|               |                              | -       | 75      | -       | mA            | USB 2.0 Device controller high speed transfer data |
|               |                              | -       | 100     | -       | mA            | 10/100 Mbit/s Ethernet transfer data               |
|               |                              | -       | 50      | -       | mA            | ADC / DAC Operation                                |
| $V_{OUT1}$    | Internal LDO voltage         | -       | 1.2     | -       | V             | Normal Operation                                   |

**Table 5-2 - Operating Voltage and Current**

**Note:** The system operating typical current measured based on each function implements normal operation with FT32 core active, and other peripherals keep idle status.

### DC Characteristics of I/O Cells

| Parameter   | Description                                  | Minimum             | Typical | Maximum | Units | Conditions                               |
|-------------|----------------------------------------------|---------------------|---------|---------|-------|------------------------------------------|
| $V_{OH}$    | Output Voltage High                          | 2.4                 | -       | -       | V     | $ I_{OH}  = 2\text{mA} \sim 16\text{mA}$ |
| $V_{OL}$    | Output Voltage Low                           | -                   | -       | 0.4     | V     | $ I_{OL}  = 2\text{mA} \sim 16\text{mA}$ |
| $V_{OPU}^*$ | Output pull-up Voltage for 5V tolerance I/Os | $V_{CCIO3V3} - 0.9$ | -       | -       | V     | $ I_{PU}  = 1\mu\text{A}$                |
| $V_{IH}$    | Input High Voltage                           | 2.0                 | -       | -       | V     | LVTTL                                    |
| $V_{IL}$    | Input Low Voltage                            | -                   | -       | 0.8     | V     | LVTTL                                    |
| $V_{TH}$    | Schmitt trigger positive threshold           | -                   | 1.6     | 2.0     | V     | LVTTL                                    |

|            | Voltage                                    |     |         |     |            |                                |
|------------|--------------------------------------------|-----|---------|-----|------------|--------------------------------|
| $V_{tl}$   | Schmitt-trigger negative threshold Voltage | 0.8 | 1.1     | -   | V          | LVTTL                          |
| $R_{pu}$   | Input pull-up resistance equivalent        | 40  | 75      | 190 | K $\Omega$ | $V_{in} = 0V$                  |
| $R_{pd}$   | Input pull-down resistance equivalent      | 40  | 75      | 190 | K $\Omega$ | $V_{in} = VCCIO3V3$            |
| $I_{in}$   | Input leakage current                      | -10 | $\pm 1$ | +10 | $\mu A$    | $V_{in} = VCCIO3V3$ or 0       |
| $C_{in}^*$ | Input Capacitance                          | -   | 2.8     | -   | pF         | VCCIO3V3 with 5V tolerance I/O |

**Table 5-3 - Digital I/O Pin Characteristics (VCCIO3V3 = +3.3V, Standard Drive Level)**

**Note:** This parameter indicates that the pull-up resistor for the 5V tolerance I/O cells cannot reach VCCIO3V3 DC level even without DC loading current.

$C_{in}$  includes the cell layout capacitance and pad capacitance.

### DC Characteristics of USB I/O Cells

| Parameter                   | Description                                          | Minimum | Typical | Maximum | Units | Conditions                    |
|-----------------------------|------------------------------------------------------|---------|---------|---------|-------|-------------------------------|
| General characteristics     |                                                      |         |         |         |       |                               |
| VUSB3V3                     | USB power supply voltage                             | 2.97    | 3.3     | 3.63    | V     | Normal operation              |
| VCC1V2*                     | USB core supply voltage                              | 1.08    | 1.2     | 1.32    | V     | Normal operation              |
| Input level for high speed  |                                                      |         |         |         |       |                               |
| $V_{hscm}$                  | Voltage of high speed data signal in the common mode | -50     | -       | 500     | mV    | -                             |
| $V_{hssq}$                  | High speed squelch detection threshold               | -       | -       | 100     | mV    | Squelch is detected           |
|                             |                                                      | 150     | -       | -       | mV    | Squelch is not detected       |
| $V_{hdsdc}$                 | High speed disconnection detection threshold         | 625     | -       | -       | mV    | Disconnection is detected     |
|                             |                                                      | -       | -       | 525     | mV    | Disconnection is not detected |
| Output level for high speed |                                                      |         |         |         |       |                               |
| $V_{hsoi}$                  | High speed idle output voltage (Differential)        | -10     | -       | 10      | mV    | -                             |
| $V_{hsol}$                  | High speed low level output                          | -10     | -       | 10      | mV    | -                             |

| Parameter                                        | Description                                            | Minimum | Typical | Maximum | Units | Conditions                                     |
|--------------------------------------------------|--------------------------------------------------------|---------|---------|---------|-------|------------------------------------------------|
|                                                  | voltage<br>(Differential)                              |         |         |         |       |                                                |
| $V_{hsoh}$                                       | High speed high level output voltage<br>(Differential) | -360    | -       | 400     | mV    | -                                              |
| $V_{chirpj}$                                     | Chirp-J output voltage<br>(Differential)               | 700     | -       | 1100    | mV    | -                                              |
| $V_{chirpk}$                                     | Chirp-K output voltage<br>(Differential)               | -900    | -       | -500    | mV    | -                                              |
| <b>Input level for full speed and low speed</b>  |                                                        |         |         |         |       |                                                |
| $V_{di}$                                         | Differential input voltage sensitivity                 | 0.2     | -       | -       | V     | $ V_{dp}-V_{dm} $                              |
| $V_{cm}$                                         | Differential common mode voltage                       | 0.8     | -       | 2.5     | V     | -                                              |
| $V_{se}$                                         | Single ended receiver threshold                        | 0.8     | -       | 2.0     | V     | -                                              |
| <b>Output level for full speed and low speed</b> |                                                        |         |         |         |       |                                                |
| $V_{ol}$                                         | Low level output voltage                               | 0       | -       | 0.3     | V     | -                                              |
| $V_{oh}$                                         | High level output voltage                              | 2.8     | -       | 3.6     | V     | -                                              |
| <b>Resistance</b>                                |                                                        |         |         |         |       |                                                |
| $R_{drv}$                                        | Driver output impedance                                | 40.5    | 45      | 49.5    | ohm   | Equivalent resistance used as an internal chip |

**Table 5-4 - USB I/O Pin (D\_DP/D\_DM, H\_DP/H\_DM) Characteristics**

**Note:** The VCC1V2 is USB Host or Peripheral transceiver core power supply input which need connect to external +1.2V voltage power while USB Host or Peripheral controller is active.

### DC Characteristics of Ethernet I/O Cells

| Parameter                      | Description                   | Minimum | Typical | Maximum | Units | Conditions       |
|--------------------------------|-------------------------------|---------|---------|---------|-------|------------------|
| <b>General characteristics</b> |                               |         |         |         |       |                  |
| VETH3V3                        | Ethernet power supply voltage | 2.97    | 3.3     | 3.63    | V     | Normal operation |

| Parameter               | Description                                     | Minimum | Typical | Maximum | Units | Conditions          |
|-------------------------|-------------------------------------------------|---------|---------|---------|-------|---------------------|
| VOUT2*                  | Ethernet LDO voltage                            | -       | 1.2     | -       | V     | Normal operation    |
| Total dissipative power | 10Base-TX mode<br>(Including TX current)        | -       | -       | 510     | mW    | 10Base-TX mode      |
|                         | 10Base-TX mode<br>(Excluding TX current)        | -       | -       | 147     | mW    | 10Base-TX mode      |
|                         | 100Base-TX mode<br>(Including TX current)       | -       | -       | 310     | mW    | 100Base-TX mode     |
|                         | 100Base-TX mode<br>(Excluding TX current)       | -       | -       | 165     | mW    | 100Base-TX mode     |
|                         | Auto-negotiation mode<br>(Including TX current) | -       | -       | 550     | mW    | 100Base-TX mode     |
|                         | Auto-negotiation mode<br>(Excluding TX current) | -       | -       | 187     | mW    | 100Base-TX mode     |
|                         | Power down mode                                 | -       | -       | 10      | mW    | Ethernet power down |

**Table 5-5 - Ethernet I/O pin (TXON/TXOP, RXIN/RXIP) Characteristics**

**Note:** The VOUT2 is the internal Regulator +1.2V voltage output which provide a power supply for the internal Ethernet transceiver.

### DC Characteristics of DAC I/O Cells

| Parameter | Description                                   | Minimum | Typical | Maximum | Units | Conditions                    |
|-----------|-----------------------------------------------|---------|---------|---------|-------|-------------------------------|
| VCC3V3A   | DAC power supply voltage                      | 2.97    | 3.3     | 3.63    | V     | Normal Operation              |
| VREFP     | Reference voltage                             | 0       | -       | VCC3V3A | V     | DCAP_REFP positive reference  |
| RES       | Resolution                                    | 10      | -       | -       | Bits  | -                             |
| INL       | Integral non-linearity error <sup>1</sup>     | -2      | -       | 2       | LSB   | VREFP = 3.2V<br>code 8 ~ 1023 |
| DNL       | Differential non-linearity error <sup>1</sup> | -1      | -       | 1       | LSB   | VREFP = 3.2V<br>code 0 ~ 1023 |

| Parameter  | Description                    | Minimum | Typical | Maximum | Units       | Conditions                                            |
|------------|--------------------------------|---------|---------|---------|-------------|-------------------------------------------------------|
| $E_o$      | Offset error <sup>1</sup>      | 2       |         | 8       | mV          | VREFP = 3.2V<br>code 0 ~ 1023<br>Non characterization |
| $E_G$      | Gain error <sup>1</sup>        | -0.4    |         | 0       | %           | VREFP = 3.2V<br>code 0 ~ 1023<br>Non characterization |
| -          | Conversion latency             | -       | -       | 1       | Clock cycle | -                                                     |
| $C_{LOAD}$ | Output load: rated capacitance | -       | -       | 10      | pF          | -                                                     |
| $R_{LOAD}$ | Output load: rated resistance  | 6.7     | -       | -       | K $\Omega$  | -                                                     |

**Table 5-6 - DAC I/O pin (DAC\_REFP, DAC0/1) Characteristics**
**Note:**

1. Non-characterization result.

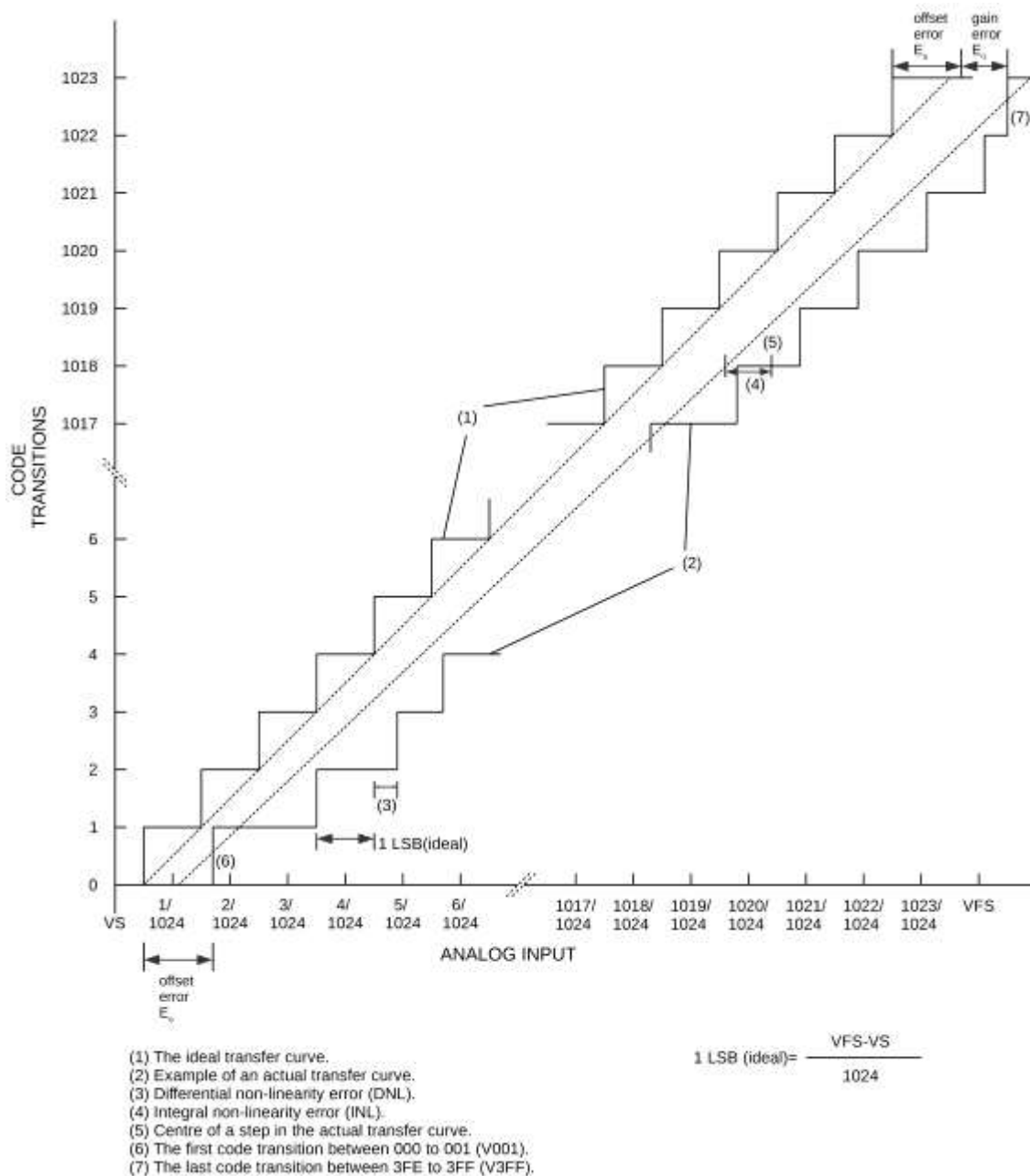
**DC Characteristics of ADC I/O Cells**

| Parameter | Description                                     | Minimum | Typical | Maximum | Units | Conditions                     |
|-----------|-------------------------------------------------|---------|---------|---------|-------|--------------------------------|
| VCC3V3A   | Analog power supply voltage                     | 2.97    | 3.3     | 3.63    | V     | Normal operation               |
| XAIN      | Analog input range                              | 0       | -       | VCC3V3A | V     | -                              |
| RES       | Resolution                                      | -       | 10      | -       | Bit   | -                              |
| INL       | Integral non-linearity error <sup>1,5</sup>     | -2      |         | 2       | LSB   | 10%-90% of VCC3V3A Reference   |
|           |                                                 | -2      |         | 2       | LSB   | Rail-to-Rail VCC3V3A reference |
| DNL       | Differential non-linearity error <sup>2,5</sup> | -1      |         | 1       | LSB   | 10%-90% of VCC3V3A Reference   |
|           |                                                 | -1      |         | 1       | LSB   | Rail-to-Rail VCC3V3A reference |
| $E_o$     | Offset error <sup>3,5</sup>                     |         | 24      |         | mV    | 10%-90% of VCC3V3A             |
|           |                                                 |         | 84      |         | mV    | Rail-to-Rail VCC3V3A reference |
| $E_G$     | Gain error <sup>4,5</sup>                       |         | -1.45   |         | %     | 10%-90% of VCC3V3A             |
|           |                                                 |         | -2.45   |         | %     | Rail-to-Rail VCC3V3A reference |

|            |             |   |   |     |      |   |
|------------|-------------|---|---|-----|------|---|
| Xsampleclk | Sample rate | - | - | 960 | KSPS | - |
|------------|-------------|---|---|-----|------|---|

**Table 5-7 - ADC I/O Pin Characteristics**
**Note:**

1. The Integral non-linearity error (INL). The maximum deviation between any actual centre of the steps and the actual straight-line transfer curve. See Figure 5-1.
2. The Differential non-linearity error (DNL). The different between the actual step width and the ideal step width. See Figure 5-1.
3. The Offset error ( $E_o$ ).The difference between first transition code and the ideal one. See Figure 5-1.
4. The Gain error ( $E_G$ ).  $E_G(\%) = \left[ \frac{V_{3FF}-V_{001}}{V_{FS}-2LSB} - 1 \right] * 100$ . See Figure 5-1.
5. Non-characterization result.


**Figure 5-1 ADC Characteristics**

## 5.3 AC Characteristics

AC Characteristics (Ambient Temperature = -40°C to +85°C)

### System clock dynamic characteristics

| Parameter                     | Value   |         |         | Unit |
|-------------------------------|---------|---------|---------|------|
|                               | Minimum | Typical | Maximum |      |
| Crystal oscillator            |         |         |         |      |
| Clock frequency               | -       | 12.00   | -       | MHz  |
| Clock accuracy                | -       | -       | 50      | ppm  |
| Period jitter                 | -       | -       | 120     | ps   |
| Cycle-to-cycle jitter         | -       | -       | 150     | ps   |
| Long-term jitter              | -       | -       | 200     | ps   |
| External clock input          |         |         |         |      |
| External clock jitter         | -       | -       | 500     | ps   |
| Clock duty cycle              | 45      | 50      | 55      | %    |
| Input voltage on pin XI/CLKIN | -       | 3.3     | -       | V    |

**Table 5-8 - System Clock Characteristics**

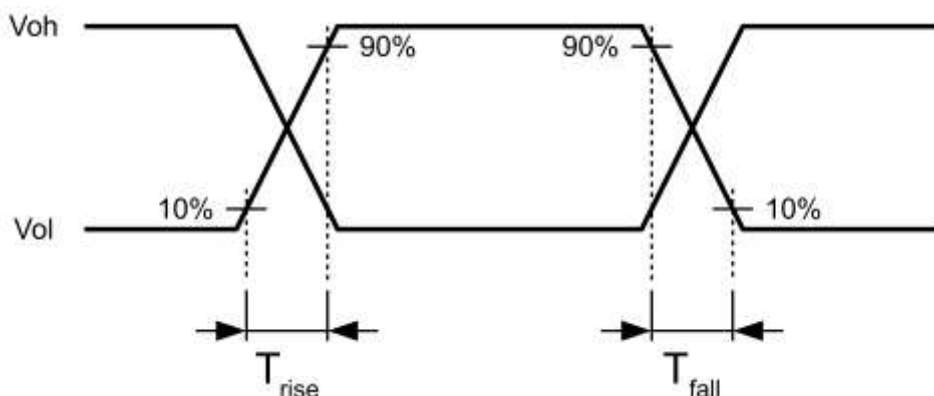
### RTC Clock Dynamic Characteristics

| Parameter                                | Value   |         |         | Unit |
|------------------------------------------|---------|---------|---------|------|
|                                          | Minimum | Typical | Maximum |      |
| Crystal oscillator                       |         |         |         |      |
| Clock frequency                          | -       | 32768   | -       | Hz   |
| External clock input                     |         |         |         |      |
| external clock jitter                    | -       | -       | 500     | ps   |
| clock duty cycle                         | 45      | 50      | 55      | %    |
| Startup time                             | -       | 0.5     | 5       | s    |
| Input voltage on pin<br>RTC_XI/RTC_CLKIN | -       | 1.2     | -       | V    |

**Table 5-9 - RTC Clock Characteristics**

**Analog USB I/O Pins Dynamic Characteristics**

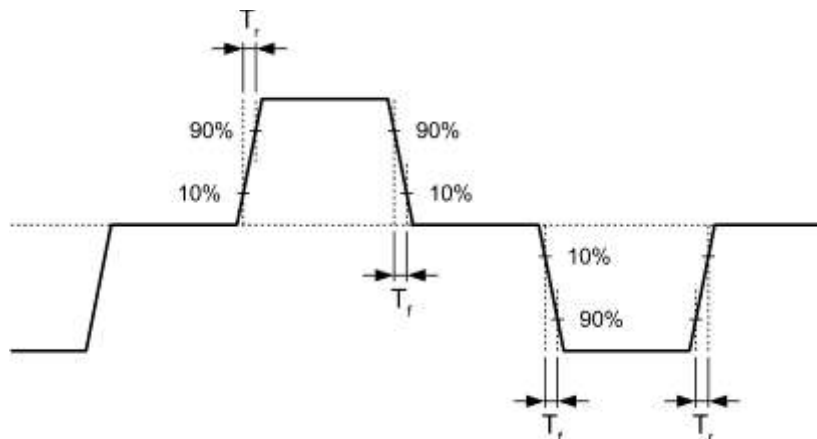
| Parameter                                   | Description                          | Minimum | Typical | Maximum | Units | Conditions                                      |
|---------------------------------------------|--------------------------------------|---------|---------|---------|-------|-------------------------------------------------|
| <b>Driver characteristic for high speed</b> |                                      |         |         |         |       |                                                 |
| $T_{hsr}$                                   | High speed differential rise time    | 500     | -       | -       | ps    | -                                               |
| $T_{hsf}$                                   | High speed differential fall time    | 500     | -       | -       | ps    | -                                               |
| <b>Driver characteristic for full speed</b> |                                      |         |         |         |       |                                                 |
| $T_{fr}$                                    | Rise time of DP/DM                   | 4       | -       | 20      | ns    | CI=50pF<br>10%~90% of  Voh-Vol                  |
| $T_{ff}$                                    | Fall time of DP/DM                   | 4       | -       | 20      | ns    | CI=50pF<br>10%~90% of  Voh-Vol                  |
| $T_{frma}$                                  | Differential rise/fall time matching | 90      | -       | 110     | %     | The first transition exclude from the idle mode |
| <b>Driver characteristic for low speed</b>  |                                      |         |         |         |       |                                                 |
| $T_{lr}$                                    | Rise time of DP/DM                   | 75      | -       | 300     | ns    | CI=200pF~600pF<br>10%~90% of  Voh-Vol           |
| $T_{lf}$                                    | Fall time of DP/DM                   | 75      | -       | 300     | ns    | CI=200pF~600pF<br>10%~90% of  Voh-Vol           |
| $T_{lrma}$                                  | Differential rise/fall time matching | 80      | -       | 125     | %     | The first transition exclude from the idle mode |

**Table 5-10 - Analog I/O Pins (D\_DP/D\_DM, H\_DP/H\_DM) Characteristics**

**Figure 5-2 - USB Rise and Fall Times for DP/DM**

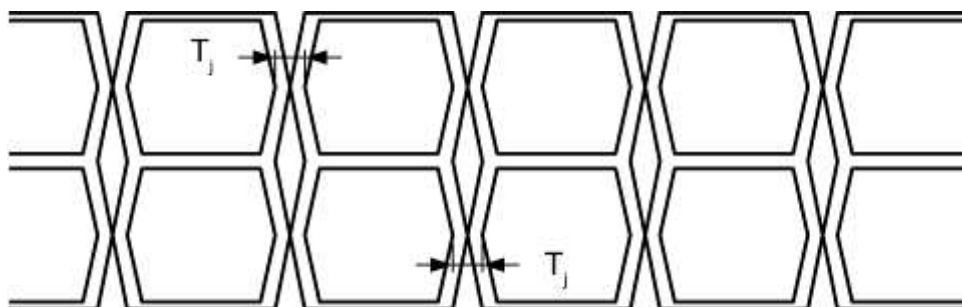
### Analog Ethernet I/O Pins Dynamic Characteristics

| Parameter                          | Description                              | Minimum | Typical | Maximum | Units | Conditions                             |
|------------------------------------|------------------------------------------|---------|---------|---------|-------|----------------------------------------|
| <b>Transmitter Characteristics</b> |                                          |         |         |         |       |                                        |
| $2 \times V_{txa}$                 | Peak-to-peak differential output voltage | 1.9     | 2.0     | 2.1     | V     | 100Base-TX mode                        |
| $T_r / T_f$                        | Signal rise/fall time                    | 3.0     | 4.0     | 5.0     | ns    | 100Base-TX mode                        |
| $T_j$                              | Output jitter                            | -       | -       | 1.4     | ns    | 100Base-TX mode, scrambled idle signal |
| $V_{txov}$                         | Overshoot                                | -       | -       | 5.0     | %     | 100Base-TX mode                        |
| <b>Receiver Characteristics</b>    |                                          |         |         |         |       |                                        |
| -                                  | Common-mode input voltage                | 2.97    | 3.3     | 3.63    | V     | -                                      |
| -                                  | Error-free cable length                  | 100     | -       | -       | meter | -                                      |

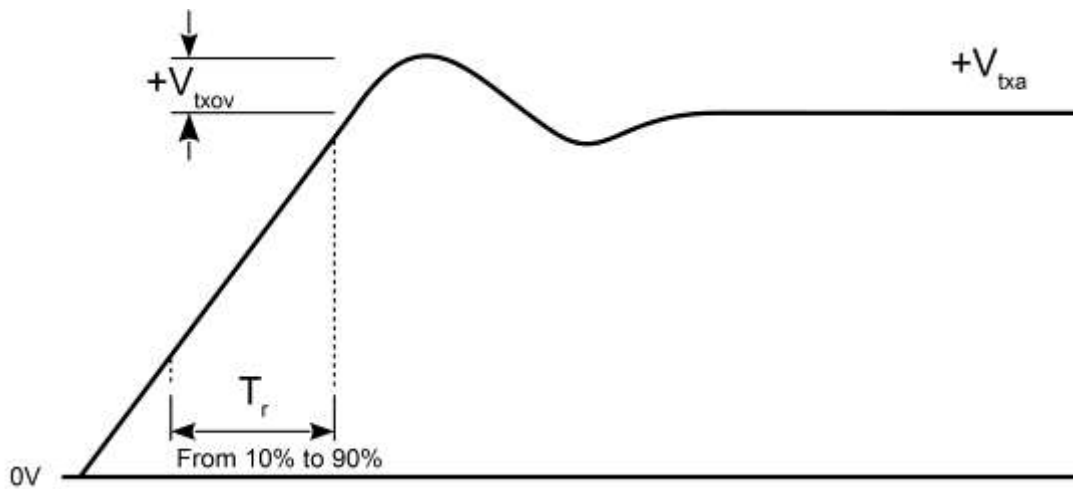
**Table 5-11 - Analog I/O Pins (TXON/TXOP, RXIN/RXIP) Characteristics**



**Figure 5-3 - 100Base-TX  $T_{r/f}$  Timing**

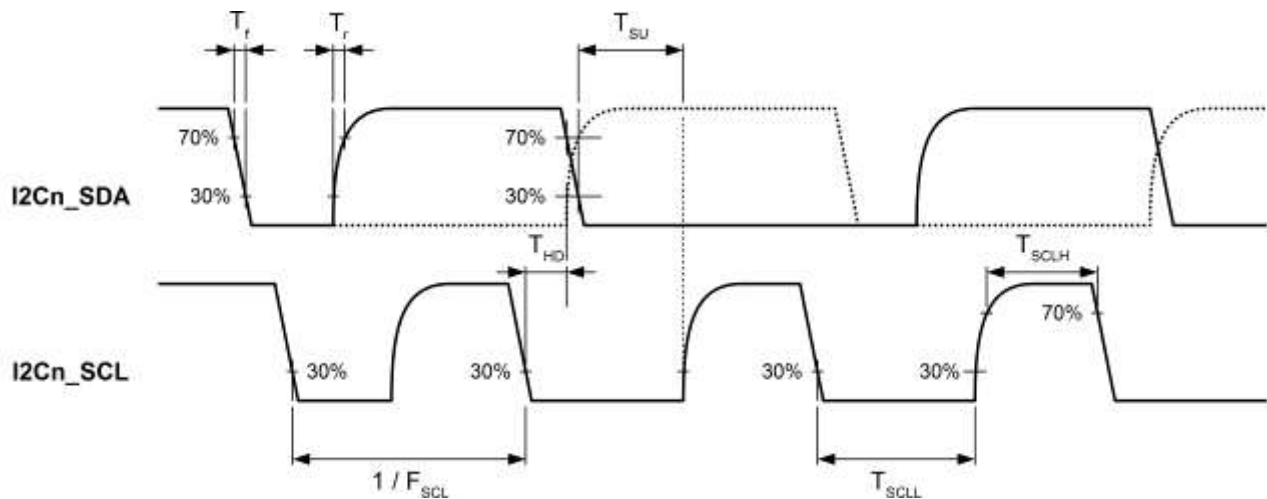
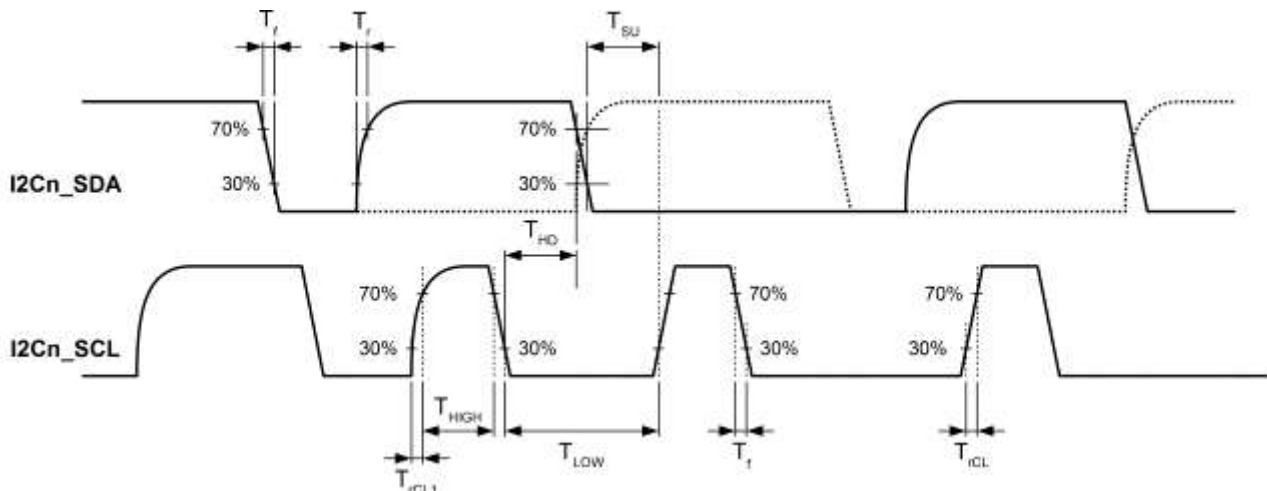


**Figure 5-4 - 100Base-TX Jitter Timing**


**Figure 5-5 - 100Base-TX Transmission Waveform**
**I<sup>2</sup>C Bus I/O Pins Dynamic Characteristics (V<sub>cc</sub> (I/O) = 3.3V)**

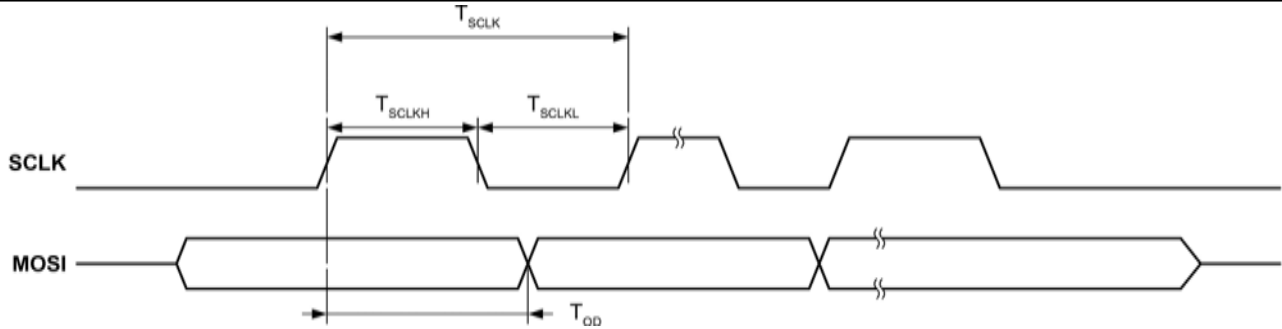
| Parameter         | Description                                               | Standard mode (SM) |      | Fast mode (FM) |     | Fast mode Plus (FM+) |      | High Speed mode (HS) |                       | Unit |
|-------------------|-----------------------------------------------------------|--------------------|------|----------------|-----|----------------------|------|----------------------|-----------------------|------|
|                   |                                                           | Min                | Max  | Min            | Max | Min                  | Max  | Min                  | Max                   |      |
| F <sub>SCL</sub>  | SCL clock frequency                                       | 0                  | 100  | 0              | 400 | 0                    | 1000 | 0                    | 3400                  | kHz  |
| T <sub>SCLL</sub> | SCL clock low period                                      | 4.7                | -    | 1.3            | -   | 0.5                  | -    | 0.320                | -                     | μs   |
| T <sub>SCLH</sub> | SCL clock high period                                     | 4.0                | -    | 0.6            | -   | 0.26                 | -    | 0.120                | -                     | μs   |
| T <sub>SU</sub>   | data setup time                                           | 250                | -    | 100            | -   | 50                   | -    | 10                   | -                     | ns   |
| T <sub>HD</sub>   | data hold time                                            | 0                  | -    | 0              | -   | 0                    | -    | 0                    | 150                   | ns   |
| T <sub>r</sub>    | rise time                                                 | -                  | 1000 | -              | 300 | -                    | 120  | 20                   | 160                   | ns   |
| T <sub>rCL1</sub> | rise time 1 <sup>st</sup> clock after S <sub>r</sub> (HS) |                    |      |                |     |                      |      | 20                   | 160                   | ns   |
| T <sub>rCL</sub>  | rise time clock (HS)                                      |                    |      |                |     |                      |      | 20                   | 80                    | ns   |
| T <sub>f</sub>    | fall time                                                 | -                  | 300  | -              | 300 | -                    | 300  | 20                   | 80 (SCL)<br>160 (SDA) | ns   |

**Table 5-12 - I2C I/O Pins (I2C0\_SCL/SDA, I2C1\_SCL/SDA) Characteristics**

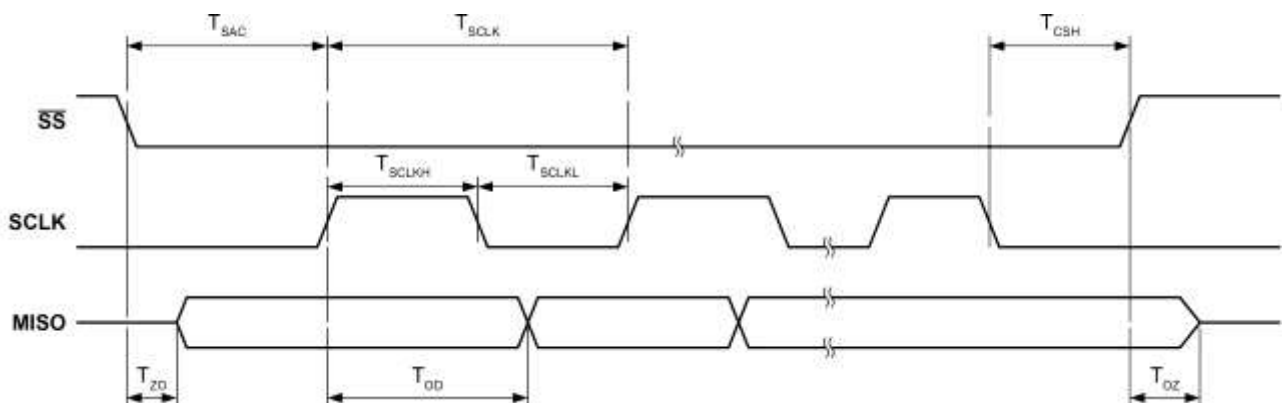

**Figure 5-6 - Definition of I<sup>2</sup>C Timing F/S mode**

**Figure 5-7 - Definition of I<sup>2</sup>C Timing HS mode**
**SPI Master I/O Pins Dynamic Characteristics ( $V_{CC} \text{ (I/O)} = 3.3\text{V}$ )**

| Parameter   | Description             | $V_{CC} \text{ (I/O)} 3.3\text{V}$ |     |     | Unit |
|-------------|-------------------------|------------------------------------|-----|-----|------|
|             |                         | Min                                | Typ | Max |      |
| $T_{SCLK}$  | SPI clock period        | 20                                 |     |     | ns   |
| $T_{SCLKL}$ | SPI clock low duration  | 19                                 |     |     | ns   |
| $T_{SCLKH}$ | SPI clock high duration | 19                                 |     |     | ns   |
| $T_{OD}$    | output data delay       | 19                                 |     | 20  | ns   |

**Table 5-13 - SPI I/O Pins (SPIM\_CLK/MOSI/MISO/SS0/SS1/SS2/SS3) Characteristics**


**Figure 5-8 - Definition of SPI Master Timing Mode 0**
**SPI Slave I/O Pins Dynamic Characteristics ( $V_{CC} (I/O) = 3.3V$ )**

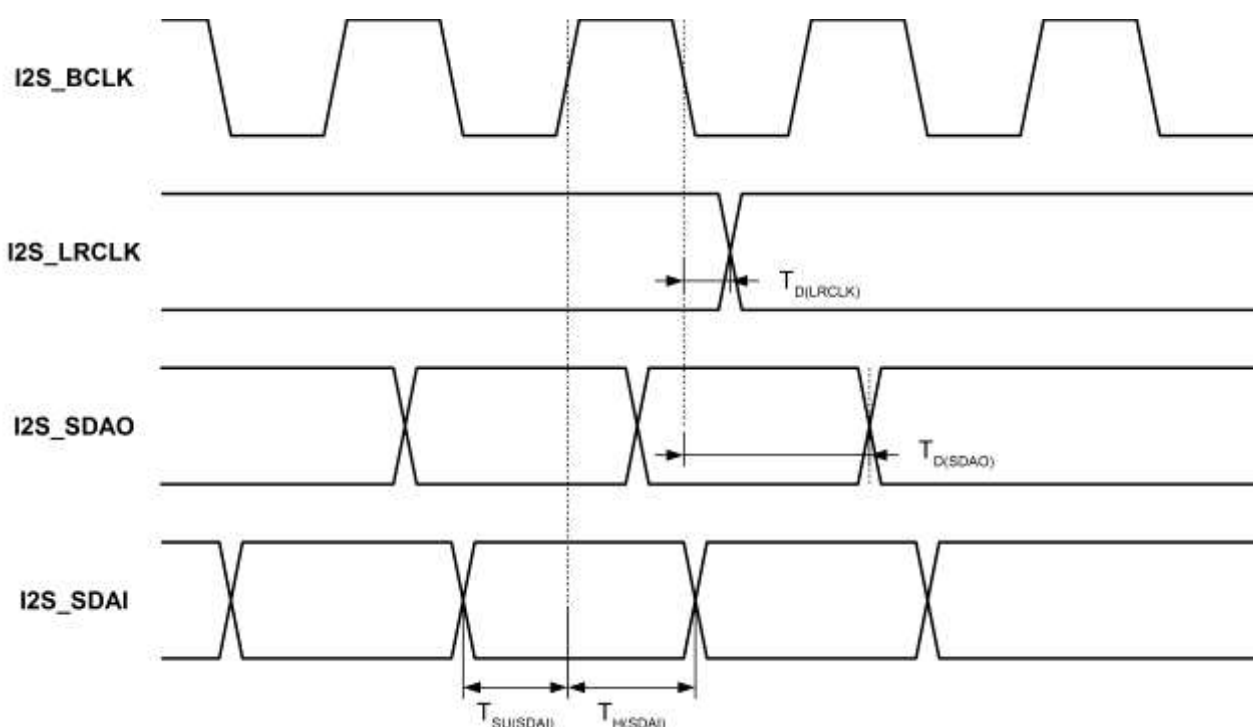
| Parameter   | Description             | $V_{CC} (I/O) 3.3V$ |     |     | Unit |
|-------------|-------------------------|---------------------|-----|-----|------|
|             |                         | Min                 | Typ | Max |      |
| $T_{SCLK}$  | SPI clock period        | 40                  |     |     | ns   |
| $T_{SCLKL}$ | SPI clock low duration  | 16                  |     |     | ns   |
| $T_{SCLKH}$ | SPI clock high duration | 16                  |     |     | ns   |
| $T_{SAC}$   | SPI access time         | 20                  |     |     | ns   |
| $T_{OD}$    | output data delay       | 7                   |     | 27  | ns   |
| $T_{ZO}$    | output enable delay     | 10                  |     |     | ns   |
| $T_{OZ}$    | output disable delay    | 10                  |     |     | ns   |
| $T_{CSH}$   | CS hold time            | 0                   |     |     | ns   |

**Table 5-14 - SPI I/O Pins (SPIS0\_CLK/MOSI/MISO/SS, SPIS1\_CLK/MOSI/MISO/SS) Characteristics**

**Figure 5-9 - Definition of SPI Slave Timing Mode 0**

## I2S Master I/O Pins Dynamic Characteristics ( $V_{cc} (I/O) = 3.3V$ )

| Parameter      | Description      | Min | Typ | Max | Unit | Conditions                 |
|----------------|------------------|-----|-----|-----|------|----------------------------|
| $T_{D(LRCLK)}$ | LRCLK delay time | 0   |     | 10  | ns   | $f_s = 48kHz$ BCLK = 256fs |
| $T_{D(SDAO)}$  | SDAO delay time  | 0   |     | 15  | ns   |                            |
| $T_{SU(SDAI)}$ | setup time       | 10  |     |     | ns   |                            |
| $T_{H(SDAI)}$  | hold time        | 10  |     |     | ns   |                            |

**Table 5-15 - I<sup>2</sup>S Master I/O Pins (I2S\_LRCLK/BCLK/SDAI/SDAO) Characteristics**

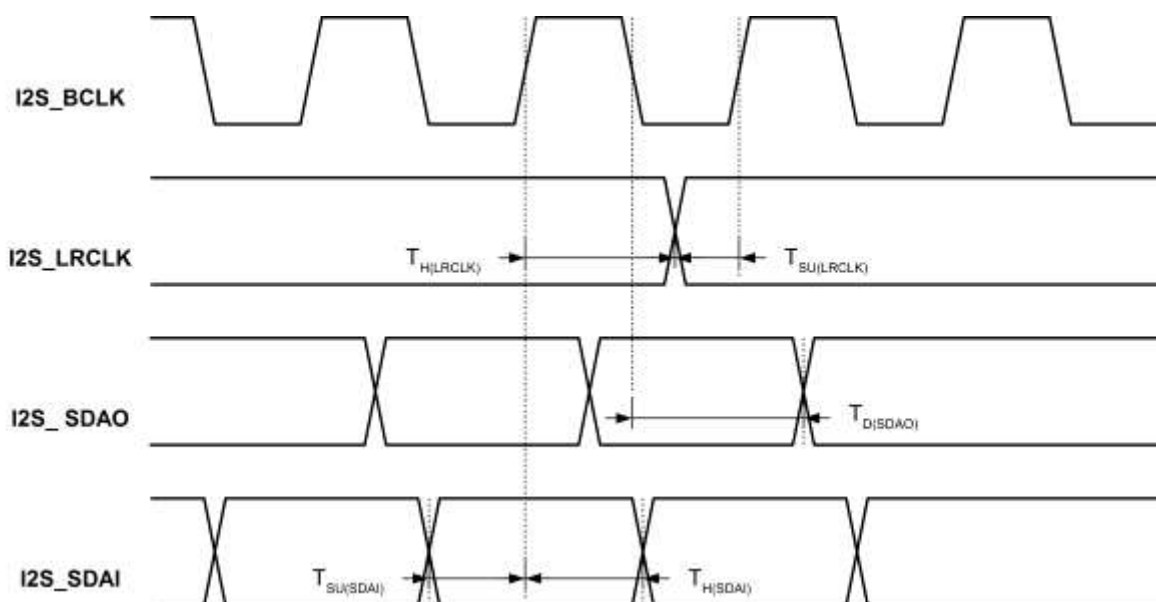


**Figure 5-10 - Definition of I<sup>2</sup>S Master Timing**

## I2S Slave I/O Pins Dynamic Characteristics ( $V_{cc} (I/O) = 3.3V$ )

| Parameter       | Description      | Min | Typ | Max | Units | Conditions                 |
|-----------------|------------------|-----|-----|-----|-------|----------------------------|
| $T_{SU(LRCLK)}$ | LRCLK setup time | 10  |     |     | ns    | $f_s = 48kHz$ BCLK = 256fs |
| $T_{H(LRCLK)}$  | LRCLK hold time  | 10  |     |     | ns    |                            |
| $T_{H(SDAO)}$   | SDAO delay time  | 0   |     | 10  | ns    |                            |
| $T_{SU(SDAI)}$  | SDAI setup time  | 10  |     |     | ns    |                            |
| $T_{H(SDAI)}$   | SDAI hold time   | 10  |     |     | ns    |                            |

**Table 5-16 - I<sup>2</sup>S Slave I/O Pins (I2S\_LRCLK/BCLK/SDAI/SDAO) Characteristics**

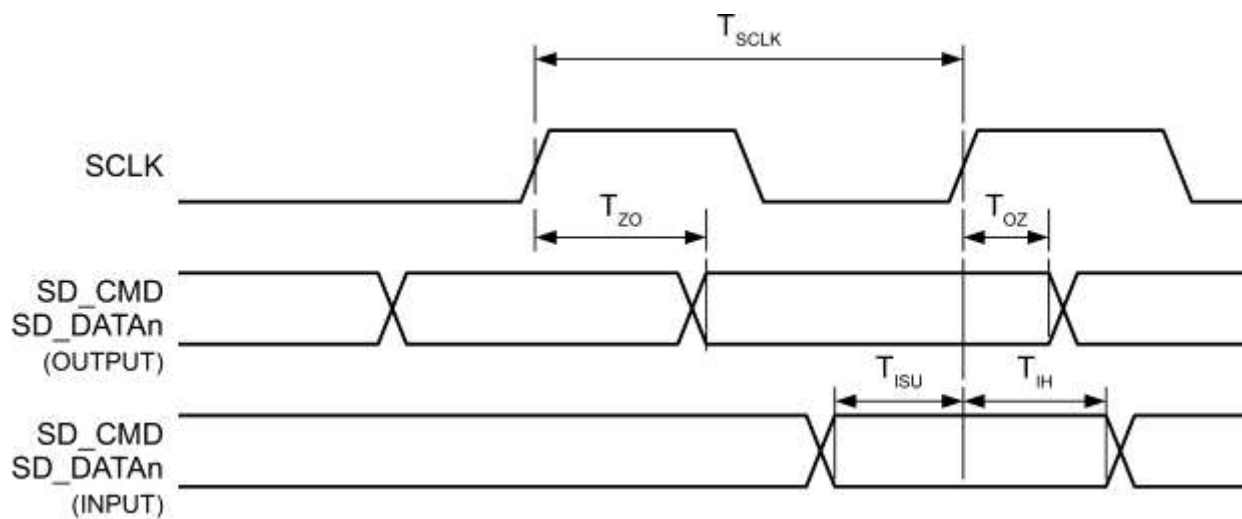

**Figure 5-11 - Definition of I<sup>2</sup>S Slave Timing**
**SD Host I/O Pins Dynamic Characteristics for 25 MHz ( $V_{cc}$  (I/O) = 3.3V)**

| Parameter  | Description                  | Conditions    | Min | Max | Unit |
|------------|------------------------------|---------------|-----|-----|------|
| $T_{SCLK}$ | clock period                 | on pin SD_CLK | 40  | -   | ns   |
| $T_{ISU}$  | data input setup time        |               | 5   | -   | ns   |
| $T_{IH}$   | data input hold time         |               | 5   | -   | ns   |
| $T_{ZO}$   | data output valid delay time |               | 0   | 14  | ns   |
| $T_{OZ}$   | data output hold time        |               | 2.5 | -   | ns   |

**Table 5-17 - SD Host I/O Pins (SD\_CLK, SD\_CMD, SD\_DATA3/DATA2/DATA1/DATA0, SD\_CD, SD\_WP) Characteristics for 25 MHz**
**SD Host I/O Pins Dynamic Characteristics for 50 MHz ( $V_{cc}$  (I/O) = 3.3V)**

| Parameter  | Description                  | Conditions    | Min | Max | Unit |
|------------|------------------------------|---------------|-----|-----|------|
| $T_{SCLK}$ | clock period                 | on pin SD_CLK | 18  | -   | ns   |
| $T_{ISU}$  | data input setup time        |               | 6   | -   | ns   |
| $T_{IH}$   | data input hold time         |               | 2   | -   | ns   |
| $T_{ZO}$   | data output valid delay time |               | -   | 14  | ns   |
| $T_{OZ}$   | data output hold time        |               | 2.5 | -   | ns   |

**Table 5-18 - SD Host I/O Pins (SD\_CLK, SD\_CMD, SD\_DATA3/DATA2/DATA1/DATA0, SD\_CD, SD\_WP) Characteristics for 50 MHz**



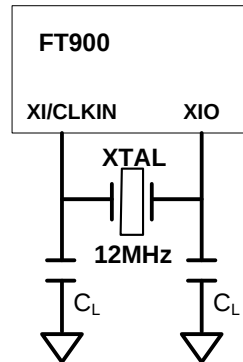
**Figure 5-12 - Definition of SD Host Timing**

## 6 Application Information

### 6.1 Crystal Oscillator

The crystal oscillator operates at a frequency of 12MHz. The oscillator can operate one of two following configuration.

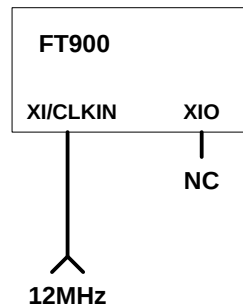
#### 6.1.1 Crystal Oscillator Application Circuit



**Figure 6-1 - Crystal Oscillator Connection**

Feedback resistance is integrated on chip; only a crystal and capacitors C<sub>L</sub> need to be connected externally. With the proper selection of crystal, the oscillator circuit can generate better quality signals for FT900/1/2/3. Parameter C<sub>L</sub> is typically 27pF but should be checked with the crystal manufacturer.

#### 6.1.2 External Clock Input



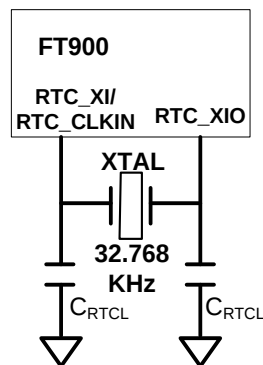
**Figure 6-2 - External Clock Input**

The 12MHz input clock signal connects XI/CLKIN to internal oscillator directly. The XIO pin can be left unconnected.

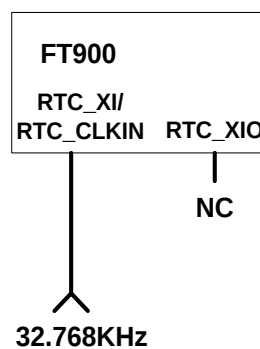
### 6.2 RTC Oscillator

In the RTC oscillator circuit Figure 6-3, only a 32.768 KHz crystal and capacitors C<sub>RTCL</sub> need to be connected externally. The parameter C<sub>RTCL</sub> should be checked with the crystal manufacturer.

An external input clock Figure 6-4 can be connected to RTC\_XI/RTC\_CLKIN if RTC\_XIO is left open.



**Figure 6-3 - RTC 32.768 KHz Oscillator Connection**



**Figure 6-4 - External 32.768 KHz Clock Input**

## 6.3 Standard I/O Pin Configuration

Figure 6-5 shows the possible pin modes for standard I/O pins with multiplex functions:

- Output driver enabled
- Output driver capability control
- Output slew rate control
- Open drain output
- Input with pull-up enabled
- Input with pull-down enabled
- Input with keeper enabled
- Input with Schmitt trigger

The default configuration for standard I/O pins is input with pull-down enabled except GPIO 0/1/2. All I/O pins have ESD protection.

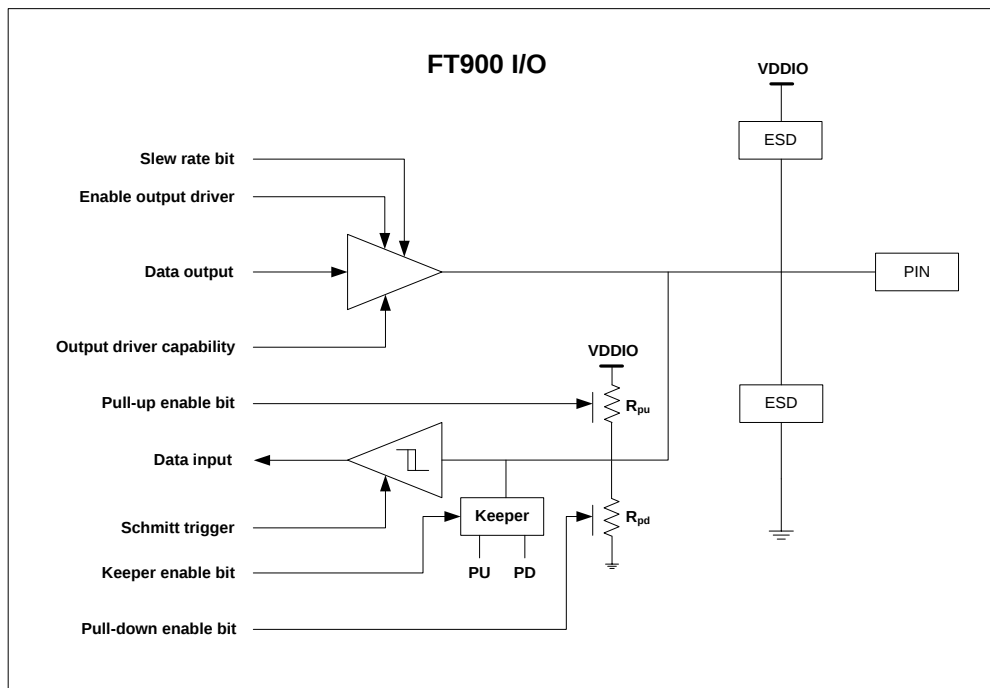


Figure 6-5 - GPIO I/O Ports Connection

## 6.4 USB 2.0 Device and Host Interface

The example diagram in Figure 6-6 shows the FT900/1/2/3 series supporting one USB 2.0 host port and one USB 2.0 device port, which makes FT900/1/2/3 system data transfer easier via a USB adapter.

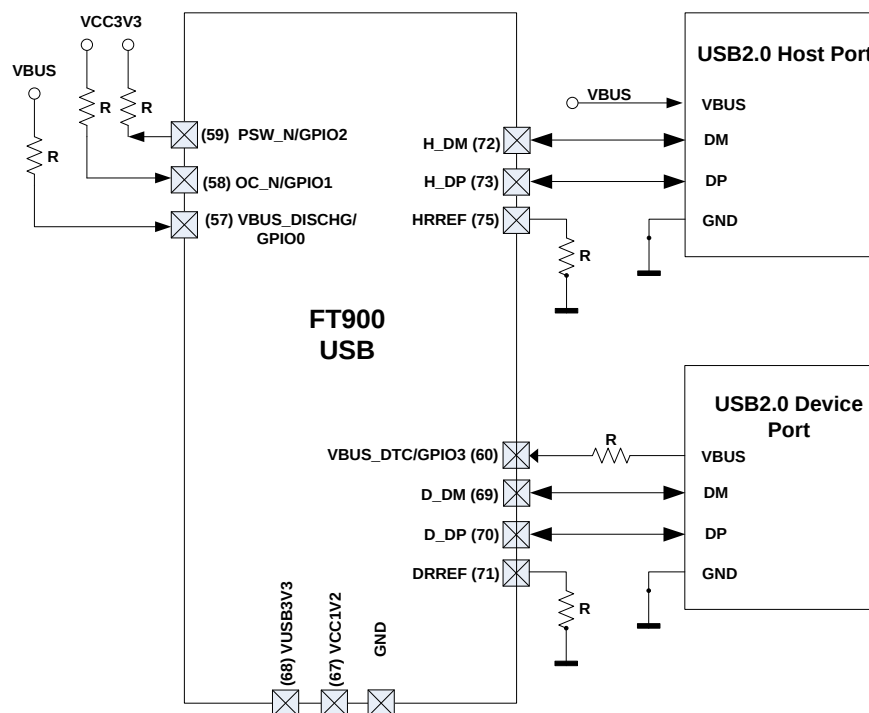


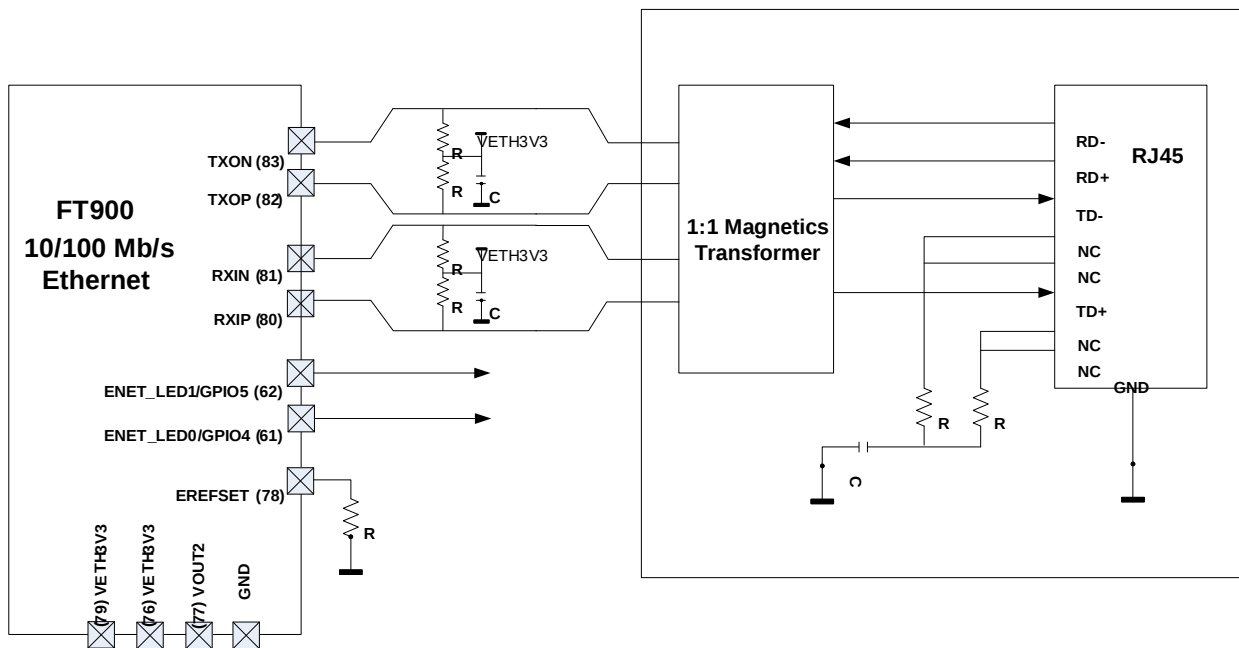
Figure 6-6 - USB 2.0 Ports Connection

The FT900/1/2/3 System shall provide I/O power (+3.3V supply) on VUSB3V3 and core power (+1.2V supply) on VCC1V2 for the USB 2.0 device / host controller. The internal band-gap gets a reference voltage from DRREF or HRREF with an external reference resistor R ( $12\text{ K}\Omega \pm 1\%$ ) respective connected to GND.

The USB 2.0 host control will provide a +5V power voltage output for VBUS and go through the PSW\_N signal to control power switching on/off.

## 6.5 10/100 Mb/s Ethernet Interface

Figure 6-7 shows the 10/100 Mb/s Ethernet port configuration via the transmit (TXON & TXOP) and receive (RXIN & RXIP) differential pair pins.



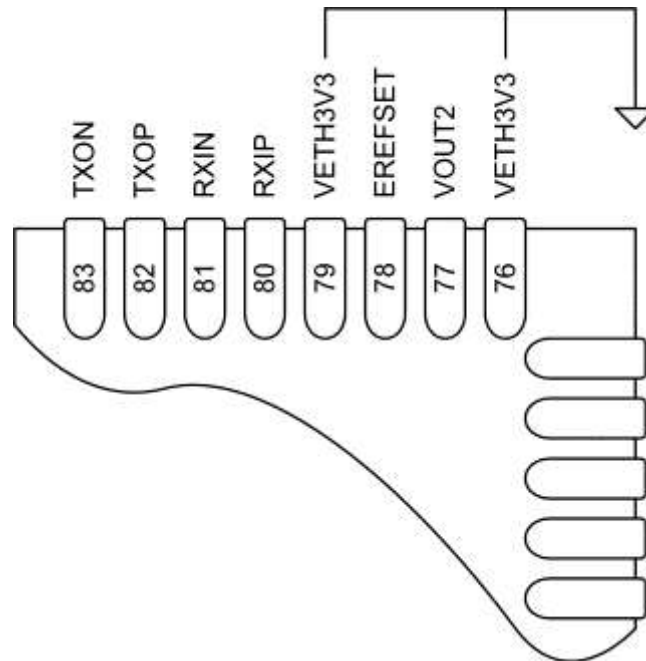
**Figure 6-7 - 10/100Mbps Ethernet Interface**

The FT900/1/2/3 Ethernet connection to a termination network should go through a 1:1 magnetics transformer and an RJ-45. For space saving, the magnetics and RJ-45 may be a single integrated component. The system shall provide +3.3V power supply for VETH3V3. The internal regulator will generate +1.2V output on VOUT2. The EREFSET connects an external resistor R ( $12.3\text{ k}\Omega \pm 1\%$ ) to GND to provide a reference voltage for the Ethernet transceiver.

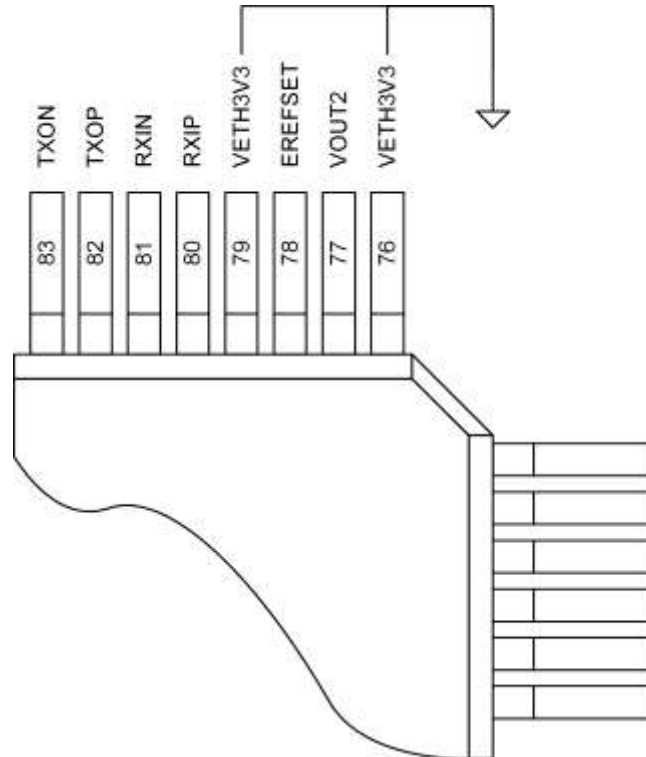
There are two Ethernet LEDs output for TX/RX transmission, Full-duplex/Half-duplex, Collision, Link or 10/100 Mb/s Speed indication. The required function should be set in the chip registers before using the LED indicator.

## 6.6 Ethernet Connection when Unused (FT900 & FT901)

If the Ethernet peripheral is not used in the end application, connect VETH3V3 to ground. See Figure 6-8 and Figure 6-9.



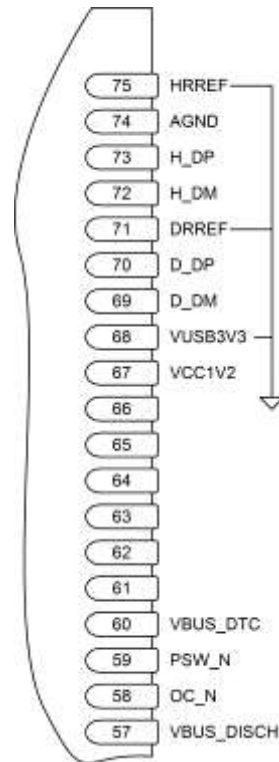
**Figure 6-8 - Unused Ethernet Connection (QFN)**



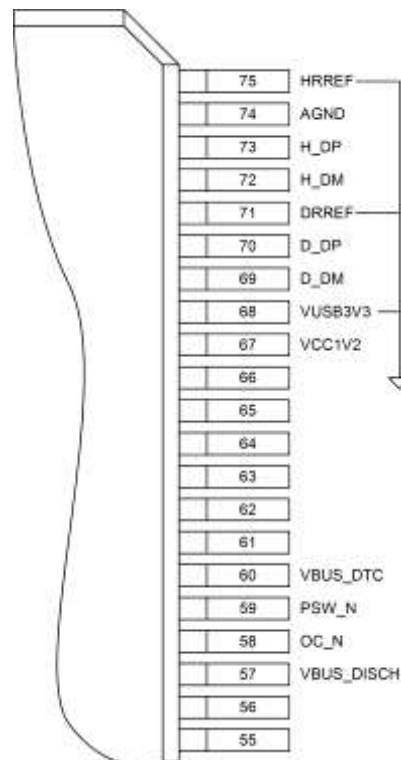
**Figure 6-9 - Unused Ethernet Connection (LQFP)**

## 6.7 USB Connection when Unused (FT900/1/2/3)

If the USB peripheral (Host and Device) is not used in the end application, connect VUSB3V3, HRREF, and DRREF to ground. See Figure 6-10 and Figure 6-11.



**Figure 6-10 - Unused USB Connection (QFN)**

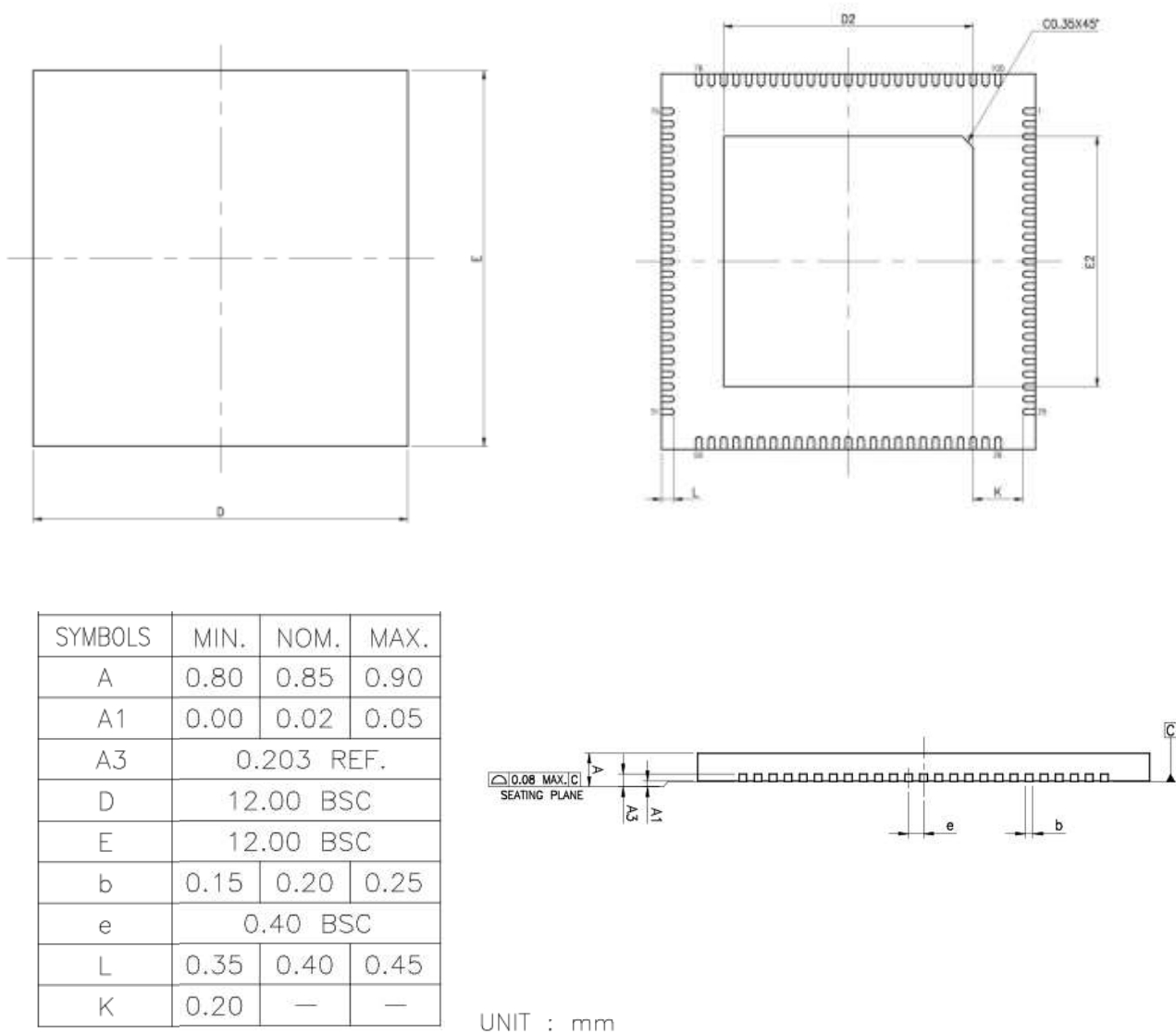


**Figure 6-11 - Unused USB Connection (LQFP)**

## 7 Package Parameters

The FT900/1/2/3 series is available in two different packages. The FT900Q/FT901Q/FT902Q/FT903Q is the QFN-100 package and the FT900L/FT901L/FT902L/FT903L is in the LQFP-100 package. The dimensions, markings and solder reflow profile for all packages are described in following sections.

### 7.1 QFN-100 Package Dimensions



| PAD SIZE | D2   |      |      | E2   |      |      | LEAD FINISH |     | JEDEC CODE |
|----------|------|------|------|------|------|------|-------------|-----|------------|
|          | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. | Pure Tin    | PPF |            |
|          | 7.95 | 8.00 | 8.05 | 7.95 | 8.00 | 8.05 | V           | X   | N/A        |

**Figure 7-1 - QFN-100 Package Dimensions**

**Note:** On the underside of the package, the exposed thermal pad should be connected to GND.

## 7.2 QFN-100 Device Marking

### 7.2.1 FT90XQ Top Side

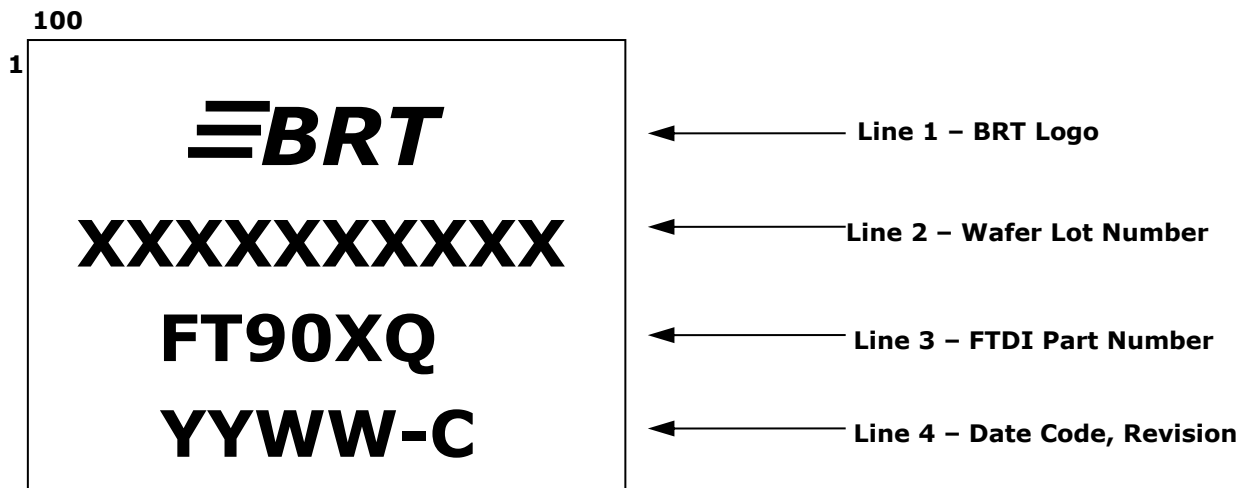


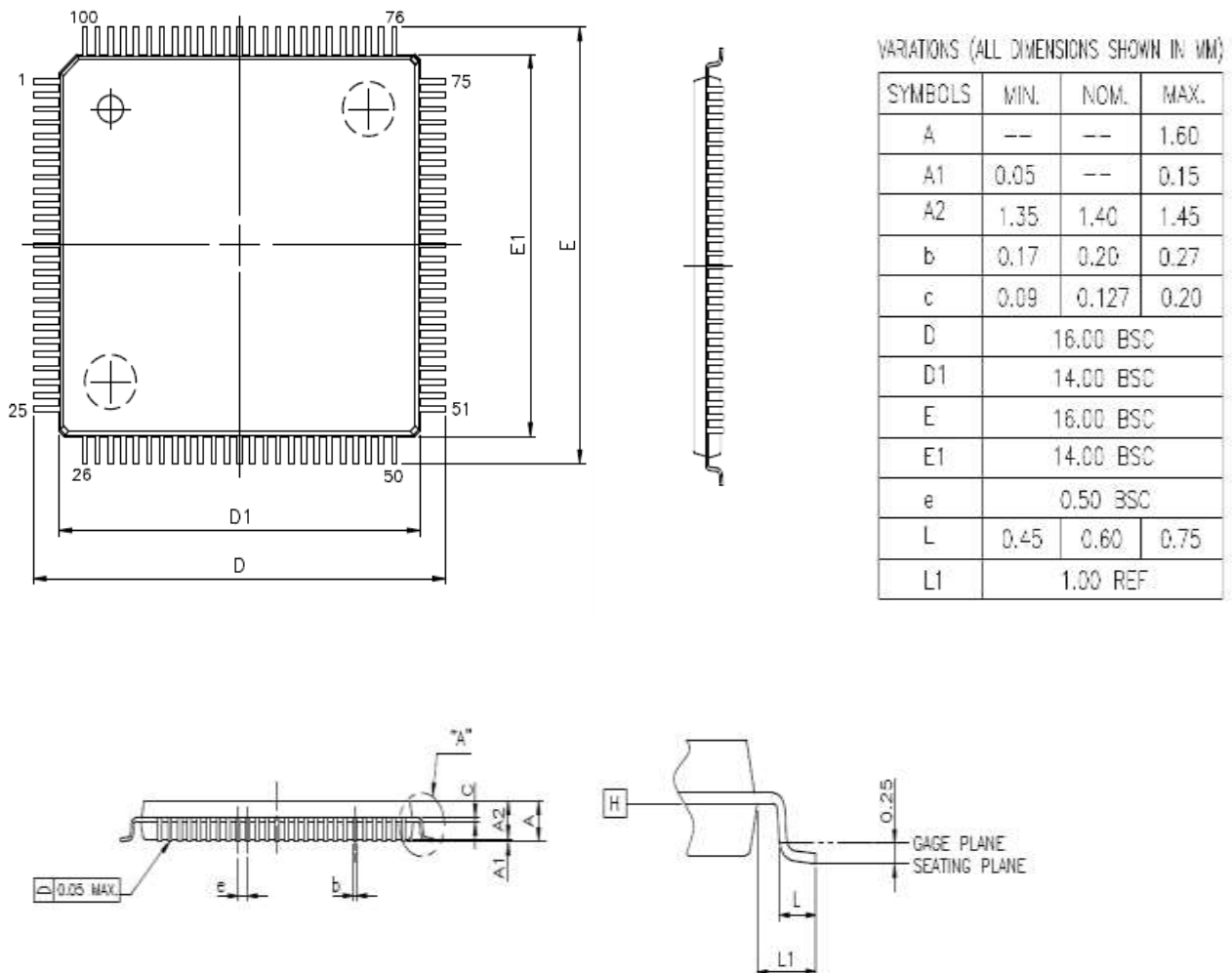
Figure 7-2 - FT90XQ Top side

#### Notes:

1. FT90XQ symbol stands for FT900Q, FT901Q, FT902Q and FT903Q.
2. YYWW = Date Code, where YY is year and WW is week number and following character C indicates the silicon revision C.
3. Marking alignment should be centre justified.
4. Laser marking should be used.

All marking dimensions should be marked proportionally. Marking font should be using standard font (Roman Simplex).

## 7.3 LQFP-100 Package Dimensions



**Figure 7-3 - LQFP-100 Package Dimensions**

## 7.4 LQFP-100 Device Marking

### 7.4.1 FT90XL Top Side

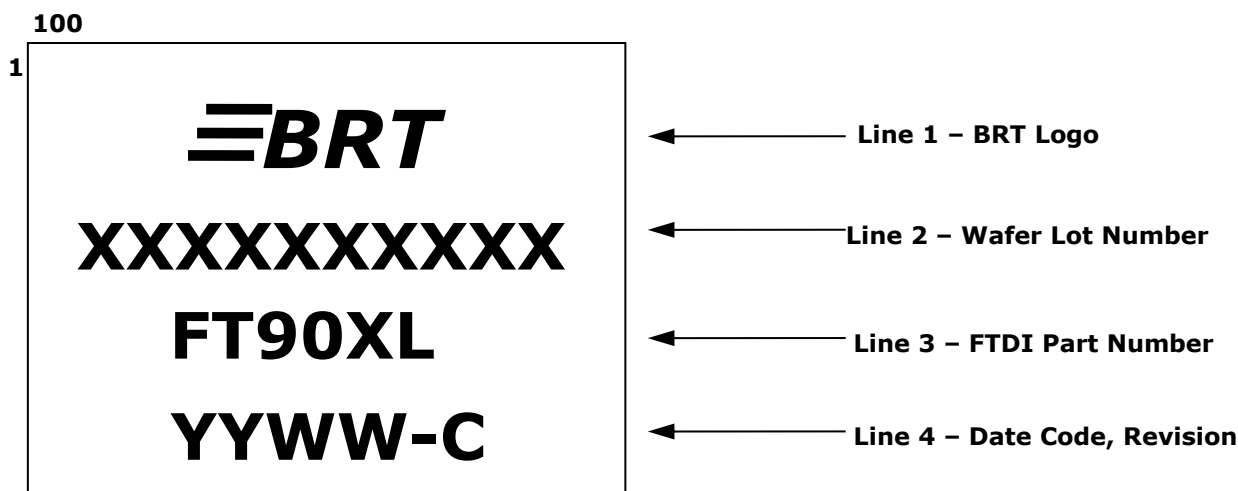


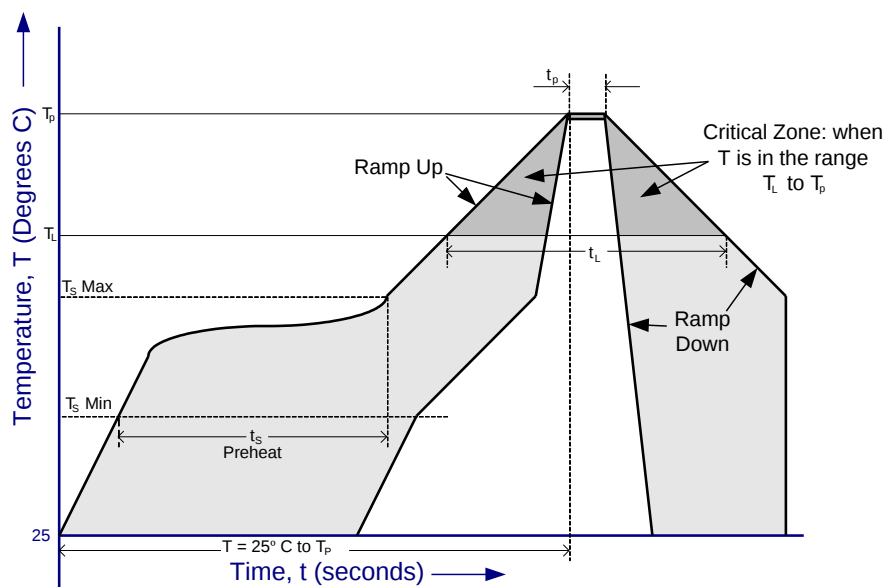
Figure 7-4 - FT90XL Top side

#### Notes:

1. FT90XL symbol stands for FT900L, FT901L, FT902L and FT903L.
2. YYWW = Date Code, where YY is year and WW is week number and following character B indicates the silicon revision B.
3. Marking alignment should be centre justified.
4. Laser marking should be used.
5. All marking dimensions should be marked proportionally. Marking font should be using standard font (Roman Simplex).

## 7.5 Solder Reflow Profile

The FT900/1/2/3 series is supplied in Pb free QFN-100 and LQFP-100 packages. The recommended solder reflow profile for all packages options is shown in Figure 7-5.



**Figure 7-5 - FT900 Solder Reflow Profile**

The recommended values for the solder reflow profile are detailed in

Table 7-1 Values are shown for both a completely Pb free solder process (i.e. the FT900 is used with Pb free solder), and for a non-Pb free solder process (i.e. the FT900 is used with non-Pb free solder).

| Profile Feature                                                                                                                                                                                                       | Pb Free Solder Process              | Non-Pb Free Solder Process          |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------|-------------------------------------|
| Average Ramp Up Rate ( $T_s$ to $T_p$ )                                                                                                                                                                               | 3°C / second Max.                   | 3°C / Second Max.                   |
| Preheat <ul style="list-style-type: none"> <li>- Temperature Min (<math>T_s</math> Min.)</li> <li>- Temperature Max (<math>T_s</math> Max.)</li> <li>- Time (<math>t_s</math> Min to <math>t_s</math> Max)</li> </ul> | 150°C<br>200°C<br>60 to 120 seconds | 100°C<br>150°C<br>60 to 120 seconds |
| Time Maintained Above Critical Temperature $T_L$ : <ul style="list-style-type: none"> <li>- Temperature (<math>T_L</math>)</li> <li>- Time (<math>t_L</math>)</li> </ul>                                              | 217°C<br>60 to 150 seconds          | 183°C<br>60 to 150 seconds          |
| Peak Temperature ( $T_p$ )                                                                                                                                                                                            | 260°C                               | 240°C                               |
| Time within 5°C of actual Peak Temperature ( $t_p$ )                                                                                                                                                                  | 20 to 40 seconds                    | 20 to 40 seconds                    |
| Ramp Down Rate                                                                                                                                                                                                        | 6°C / second Max.                   | 6°C / second Max.                   |
| Time for $T = 25^\circ\text{C}$ to Peak Temperature, $T_p$                                                                                                                                                            | 8 minutes Max.                      | 6 minutes Max.                      |

**Table 7-1 - Reflow Profile Parameter Values**

## 8 Contact Information

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## Appendix A – References

### Document References

[FT90X Product Page](#)

[AN\\_324 FT900 User Manual](#)

[BRT AN\\_020 FT90x Revision C User Manual](#)

AN\_341 FT32\_Technical\_Manual (available under NDA. Contact FTDI for more information).

[USB 2.0 Specification](#)

[Battery Charging Specification Revision 1.2 \(BC 1.2\)](#)

[BRT AN\\_019 Migration Guide Moving from FT90x Revision B to FT90x Revision C](#)

### Acronyms and Abbreviations

| Terms | Description                    |
|-------|--------------------------------|
| ADC   | Analog-to-Digital Converter    |
| BCD   | Battery Charge Device          |
| CAN   | Controller Area Network        |
| CDP   | Charging Downstream Port       |
| CPI   | Camera Parallel Interface      |
| DAC   | Digital-to-Analog Converter    |
| DAQ   | Data Acquisition               |
| DCP   | Dedicated Charging Port        |
| DNL   | Differential Nonlinearity      |
| FCS   | Ethernet Frame Check Sequence  |
| FIFO  | First In First Out             |
| GPIO  | General Purpose Input / Output |
| INL   | Integral Nonlinearity          |
| I/O   | Input / Output                 |
| LQFP  | Low profile Quad Flat Package  |

|      |                                             |
|------|---------------------------------------------|
| LSB  | Least Significant Bit                       |
| MMC  | Multimedia Card                             |
| MSPS | Mega Samples Per Second                     |
| NMI  | Non-Maskable Interrupt input                |
| OTP  | One-Time Programmable (memory)              |
| POR  | Power On Reset                              |
| PWM  | Pulse Width Modulator                       |
| QFN  | Quad Flat No-Lead                           |
| RTC  | Real Time Clock                             |
| SD   | Secure Digital                              |
| SDP  | Standard Downstream Port                    |
| SPI  | Serial Peripheral Interface                 |
| UART | Universal Asynchronous Receiver/Transmitter |
| UHS  | Ultra High Speed                            |
| USB  | Universal Serial Bus                        |
| NDA  | Non-Disclosure Agreement                    |

## Appendix B - List of Figures and Tables

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## Appendix C - Revision History

Document Title: FT900/1/2/3 Revision C Embedded Microcontroller Datasheet  
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Product Page: <http://brtchip.com/product>  
Document Feedback: [Send Feedback](#)

| Revision    | Changes             | Date       |
|-------------|---------------------|------------|
| Version 1.0 | Initial Release     | 2017-08-02 |
| Version 1.1 | Updated Part Number | 2018-01-23 |